

# NTAG213/215/216

NFC Forum Type 2 Tag compliant IC with 144/504/888 bytes user memory

Rev. 3.1 — 13 December 2013  
265331

Product data sheet  
COMPANY PUBLIC

## 1. General description

NTAG213, NTAG215 and NTAG216 have been developed by NXP Semiconductors as standard NFC tag ICs to be used in mass market applications such as retail, gaming and consumer electronics, in combination with NFC devices or NFC compliant Proximity Coupling Devices. NTAG213, NTAG215 and NTAG216 (from now on, generally called NTAG21x) are designed to fully comply to NFC Forum Type 2 Tag ([Ref. 2](#)) and ISO/IEC14443 Type A ([Ref. 1](#)) specifications.

Target applications include Out-of-Home and print media smart advertisement, SoLoMo applications, product authentication, NFC shelf labels, mobile companion tags.

Target use cases include Out-of-Home smart advertisement, product authentication, mobile companion tags, Bluetooth or Wi-Fi pairing, electronic shelf labels and business cards. NTAG21x memory can also be segmented to implement multiple applications at the same time.

Thanks to the high input capacitance, NTAG21x tag ICs are particularly tailored for applications requiring small footprints, without compromise on performance. Small NFC tags can be more easily embedded into e.g. product labels or electronic devices.

The mechanical and electrical specifications of NTAG21x are tailored to meet the requirements of inlay and tag manufacturers.

### 1.1 Contactless energy and data transfer

Communication to NTAG21x can be established only when the IC is connected to an antenna. Form and specification of the coil is out of scope of this document.

When NTAG21x is positioned in the RF field, the high speed RF communication interface allows the transmission of the data with a baud rate of 106 kbit/s.



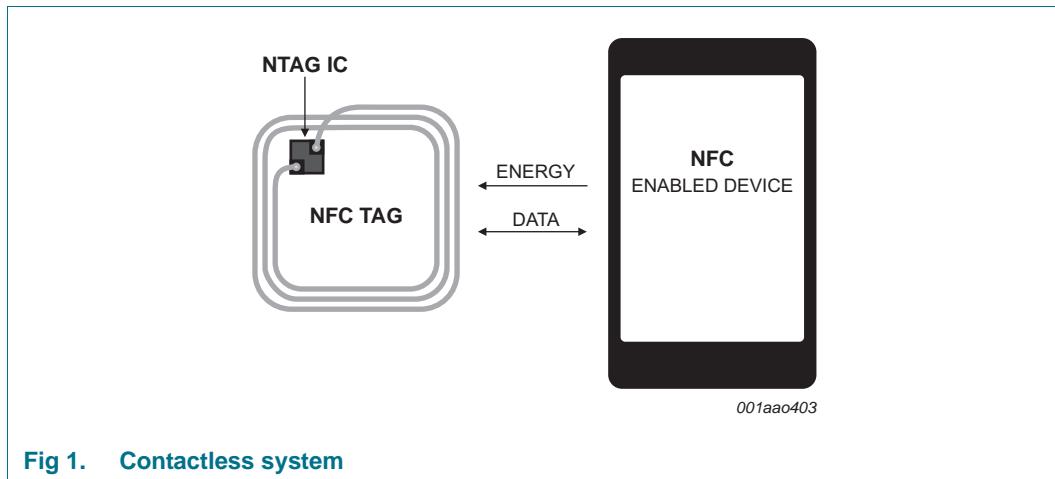


Fig 1. Contactless system

## 1.2 Simple deployment and user convenience

NTAG21x offers specific features designed to improve integration and user convenience:

- The fast read capability allows to scan the complete NDEF message with only one FAST\_READ command, thus reducing the overhead in high throughput production environments
- The improved RF performance allows for more flexibility in the choice of shape, dimension and materials
- The option for 75  $\mu\text{m}$  IC thickness enables the manufacturing of ultrathin tags, for a more convenient integration in e.g. magazines or gaming cards.

## 1.3 Security

- Manufacturer programmed 7-byte UID for each device
- Pre-programmed Capability container with one time programmable bits
- Field programmable read-only locking function
- ECC based originality signature
- 32-bit password protection to prevent unauthorized memory operations

## 1.4 NFC Forum Tag 2 Type compliance

NTAG21x IC provides full compliance to the NFC Forum Tag 2 Type technical specification (see [Ref. 2](#)) and enables NDEF data structure configurations (see [Ref. 3](#)).

## 1.5 Anticollision

An intelligent anticollision function allows to operate more than one tag in the field simultaneously. The anticollision algorithm selects each tag individually and ensures that the execution of a transaction with a selected tag is performed correctly without interference from another tag in the field.

## 2. Features and benefits

---

- Contactless transmission of data and supply energy
- Operating frequency of 13.56 MHz
- Data transfer of 106 kbit/s
- Data integrity of 16-bit CRC, parity, bit coding, bit counting
- Operating distance up to 100 mm (depending on various parameters as e.g. field strength and antenna geometry)
- 7-byte serial number (cascade level 2 according to ISO/IEC 14443-3)
- UID ASCII mirror for automatic serialization of NDEF messages
- Automatic NFC counter triggered at read command
- NFC counter ASCII mirror for automatic adding the NFC counter value to the NDEF message
- ECC based originality signature
- Fast read command
- True anticollision
- 50 pF input capacitance

### 2.1 EEPROM

- 180, 540 or 924 bytes organized in 45, 135 or 231 pages with 4 bytes per page
- 144, 504 or 888 bytes freely available user Read/Write area (36, 126 or 222 pages)
- 4 bytes initialized capability container with one time programmable access bits
- Field programmable read-only locking function per page for the first 16 pages
- Field programmable read-only locking function above the first 16 pages per double page for NTAG213 or per 16 pages for NTAG215 and NTAG216
- Configurable password protection with optional limit of unsuccessful attempts
- Anti-tearing support for capability container (CC) and lock bits
- ECC supported originality check
- Data retention time of 10 years
- Write endurance 100.000 cycles

## 3. Applications

---

- Smart advertisement
- Goods and device authentication
- Call request
- SMS
- Call to action
- Voucher and coupons
- Bluetooth or Wi-Fi pairing
- Connection handover
- Product authentication
- Mobile companion tags
- Electronic shelf labels
- Business cards

## 4. Quick reference data

**Table 1. Quick reference data**

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
$C_i$	input capacitance	[1]	-	50.0	-	pF
$f_i$	input frequency		-	13.56	-	MHz
<b>EEPROM characteristics</b>						
$t_{ret}$	retention time	$T_{amb} = 22 \text{ }^{\circ}\text{C}$	10	-	-	years
$N_{endu(W)}$	write endurance	$T_{amb} = 22 \text{ }^{\circ}\text{C}$	100000	-	-	cycles

[1] LCR meter,  $T_{amb} = 22 \text{ }^{\circ}\text{C}$ ,  $f_i = 13.56 \text{ MHz}$ , 2 V RMS.

## 5. Ordering information

**Table 2. Ordering information**

Type number	Package			Version
	Name	Description		
NT2H1311G0DUF	FFC Bump	8 inch wafer, 75 $\mu\text{m}$ thickness, on film frame carrier, electronic fail die marking according to SECS-II format), Au bumps, 144 bytes user memory, 50 pF input capacitance		-
NT2H1311G0DUD	FFC Bump	8 inch wafer, 120 $\mu\text{m}$ thickness, on film frame carrier, electronic fail die marking according to SECS-II format), Au bumps, 144 bytes user memory, 50 pF input capacitance		-
NT2H1511G0DUF	FFC Bump	8 inch wafer, 75 $\mu\text{m}$ thickness, on film frame carrier, electronic fail die marking according to SECS-II format), Au bumps, 504 bytes user memory, 50 pF input capacitance		-
NT2H1511G0DUD	FFC Bump	8 inch wafer, 120 $\mu\text{m}$ thickness, on film frame carrier, electronic fail die marking according to SECS-II format), Au bumps, 504 bytes user memory, 50 pF input capacitance		-
NT2H1611G0DUF	FFC Bump	8 inch wafer, 75 $\mu\text{m}$ thickness, on film frame carrier, electronic fail die marking according to SECS-II format), Au bumps, 888 bytes user memory, 50 pF input capacitance		-
NT2H1611G0DUD	FFC Bump	8 inch wafer, 120 $\mu\text{m}$ thickness, on film frame carrier, electronic fail die marking according to SECS-II format), Au bumps, 888 bytes user memory, 50 pF input capacitance		-

## 6. Block diagram

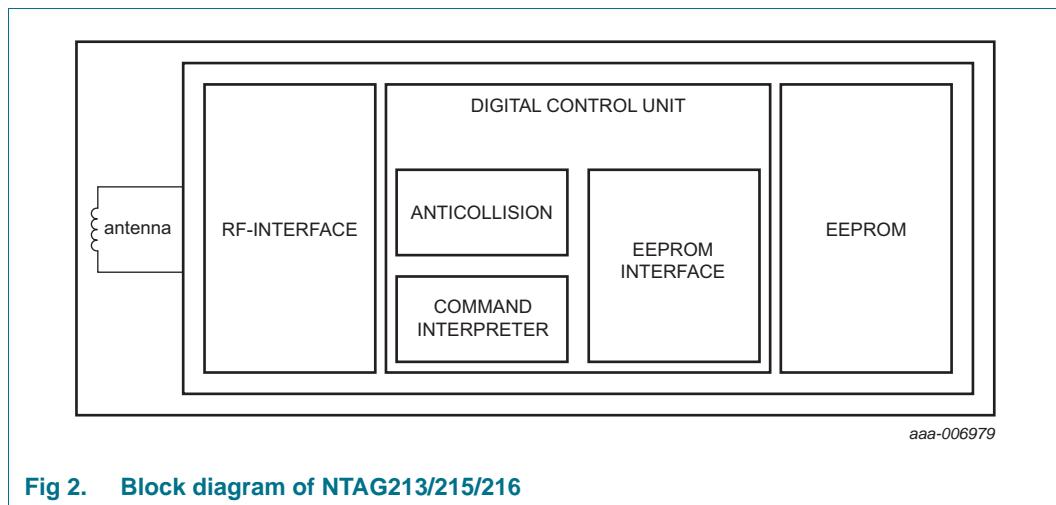


Fig 2. Block diagram of NTAG213/215/216

## 7. Pinning information

### 7.1 Pinning

The pinning of the NTAG213/215/216 wafer delivery is shown in section “Bare die outline” (see [Section 13.2](#)).

**Table 3. Pin allocation table**

Pin	Symbol	
LA	LA	Antenna connection LA
LB	LB	Antenna connection LB

## 8. Functional description

### 8.1 Block description

NTAG21x ICs consist of a 180 (NTAG213), 540 bytes (NTAG215) or 924 bytes (NTAG216) EEPROM, RF interface and Digital Control Unit (DCU). Energy and data are transferred via an antenna consisting of a coil with a few turns which is directly connected to NTAG21x. No further external components are necessary. Refer to [Ref. 4](#) for details on antenna design.

- RF interface:
  - modulator/demodulator
  - rectifier
  - clock regenerator
  - Power-On Reset (POR)
  - voltage regulator
- Anticollision: multiple cards may be selected and managed in sequence
- Command interpreter: processes memory access commands supported by the NTAG21x
- EEPROM interface
- NTAG213 EEPROM: 180 bytes, organized in 45 pages of 4 byte per page.
  - 26 bytes reserved for manufacturer and configuration data
  - 34 bits used for the read-only locking mechanism
  - 4 bytes available as capability container
  - 144 bytes user programmable read/write memory
- NTAG215 EEPROM: 540 bytes, organized in 135 pages of 4 byte per page.
  - 26 bytes reserved for manufacturer and configuration data
  - 28 bits used for the read-only locking mechanism
  - 4 bytes available as capability container
  - 504 bytes user programmable read/write memory
- NTAG216 EEPROM: 924 bytes, organized in 231 pages of 4 byte per page.
  - 26 bytes reserved for manufacturer and configuration data

- 37 bits used for the read-only locking mechanism
- 4 bytes available as capability container
- 888 bytes user programmable read/write memory

## 8.2 RF interface

The RF-interface is based on the ISO/IEC 14443 Type A standard.

During operation, the NFC device generates an RF field. The RF field must always be present (with short pauses for dat communication) as it is used for both communication and as power supply for the tag.

For both directions of data communication, there is one start bit at the beginning of each frame. Each byte is transmitted with an odd parity bit at the end. The LSB of the byte with the lowest address of the selected block is transmitted first. The maximum length of a NFC device to tag frame is 163 bits (16 data bytes + 2 CRC bytes =  $16 \times 9 + 2 \times 9 + 1$  start bit). The maximum length of a fixed size tag to NFC device frame is 307 bits (32 data bytes + 2 CRC bytes =  $32 \times 9 + 2 \times 9 + 1$  start bit). The FAST\_READ command has a variable frame length depending on the start and end address parameters. The maximum frame length supported by the NFC device needs to be taken into account when issuing this command.

For a multi-byte parameter, the least significant byte is always transmitted first. As an example, when reading from the memory using the READ command, byte 0 from the addressed block is transmitted first, followed by bytes 1 to byte 3 out of this block. The same sequence continues for the next block and all subsequent blocks.

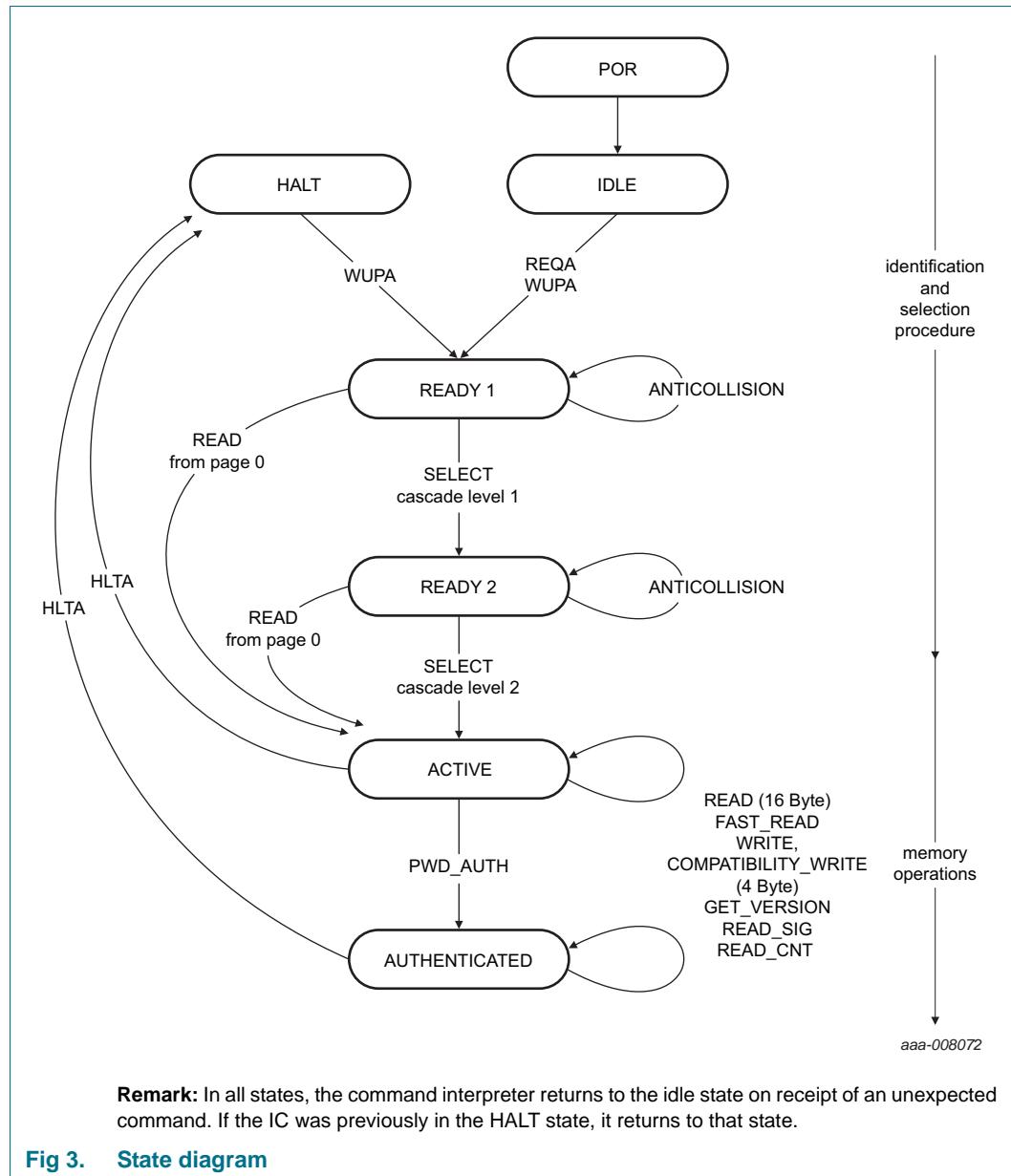
## 8.3 Data integrity

Following mechanisms are implemented in the contactless communication link between NFC device and NTAG to ensure very reliable data transmission:

- 16 bits CRC per block
- parity bits for each byte
- bit count checking
- bit coding to distinguish between “1”, “0” and “no information”
- channel monitoring (protocol sequence and bit stream analysis)

## 8.4 Communication principle

The commands are initiated by the NFC device and controlled by the Digital Control Unit of the NTAG21x. The command response is depending on the state of the IC and for memory operations also on the access conditions valid for the corresponding page.



#### 8.4.1 IDLE state

After a power-on reset (POR), NTAG21x switches to the IDLE state. It only exits this state when a REQA or a WUPA command is received from the NFC device. Any other data received while in this state is interpreted as an error and NTAG21x remains in the IDLE state.

After a correctly executed HLTA command i.e. out of the ACTIVE or AUTHENTICATED state, the default waiting state changes from the IDLE state to the HALT state. This state can then be exited with a WUPA command only.

#### 8.4.2 READY1 state

In this state, the NFC device resolves the first part of the UID (3 bytes) using the ANTICOLLISION or SELECT commands in cascade level 1. This state is correctly exited after execution of either of the following commands:

- SELECT command from cascade level 1: the NFC device switches NTAG21x into READY2 state where the second part of the UID is resolved.
- READ command (from address 0): all anticollision mechanisms are bypassed and the NTAG21x switches directly to the ACTIVE state.

Remark: If more than one NTAG is in the NFC device field, a READ command from address 0 selects all NTAG21x devices. In this case, a collision occurs due to different serial numbers. Any other data received in the READY1 state is interpreted as an error and depending on its previous state NTAG21x returns to the IDLE or HALT state.

#### 8.4.3 READY2 state

In this state, NTAG21x supports the NFC device in resolving the second part of its UID (4 bytes) with the cascade level 2 ANTICOLLISION command. This state is usually exited using the cascade level 2 SELECT command.

Alternatively, READY2 state can be skipped using a READ command (from address 0) as described for the READY1 state.

**Remark:** The response of NTAG21x to the cascade level 2 SELECT command is the Select AcKnowledge (SAK) byte. In accordance with ISO/IEC 14443, this byte indicates if the anticollision cascade procedure has finished. NTAG21x is now uniquely selected and only this device will communicate with the NFC device even when other contactless devices are present in the NFC device field. If more than one NTAG21x is in the NFC device field, a READ command from address 0 selects all NTAG21x devices. In this case, a collision occurs due to the different serial numbers. Any other data received when the device is in this state is interpreted as an error. Depending on its previous state the NTAG21x returns to either the IDLE state or HALT state.

#### 8.4.4 ACTIVE state

All memory operations and other functions like the originality signature read-out are operated in the ACTIVE state.

The ACTIVE state is exited with the HLTA command and upon reception NTAG21x transits to the HALT state. Any other data received when the device is in this state is interpreted as an error. Depending on its previous state NTAG21x returns to either the IDLE state or HALT state.

NTAG21x transits to the AUTHENTICATED state after successful password verification using the PWD\_AUTH command.

#### 8.4.5 AUTHENTICATED state

In this state, all operations on memory pages, which are configured as password verification protected, can be accessed.

The AUTHENTICATED state is exited with the HLTA command and upon reception NTAG21x transits to the HALT state. Any other data received when the device is in this state is interpreted as an error. Depending on its previous state NTAG21x returns to either the IDLE state or HALT state.

#### 8.4.6 HALT state

HALT and IDLE states constitute the two wait states implemented in NTAG21x. An already processed NTAG21x can be set into the HALT state using the HLTA command. In the anticollision phase, this state helps the NFC device to distinguish between processed tags and tags yet to be selected. NTAG21x can only exit this state on execution of the WUPA command. Any other data received when the device is in this state is interpreted as an error and NTAG21x state remains unchanged.

## 8.5 Memory organization

The EEPROM memory is organized in pages with 4 bytes per page. NTAG213 variant has 45 pages, NTAG215 variant has 135 pages and NTAG216 variant has 231 pages in total. The memory organization can be seen in [Figure 4](#), [Figure 5](#) and [Figure 6](#), the functionality of the different memory sections is described in the following sections.

Page Adr		Byte number within a page				Description		
Dec	Hex	0	1	2	3			
0	0h					Manufacturer data and static lock bytes		
1	1h					Capability Container		
2	2h	serial number	internal	lock bytes	lock bytes			
3	3h	Capability Container (CC)						
4	4h	user memory						
5	5h							
...	...							
38	26h							
39	27h							
40	28h	dynamic lock bytes		RFUI		Dynamic lock bytes		
41	29h	CFG 0						
42	2Ah	CFG 1						
43	2Bh	PWD						
44	2Ch	PACK		RFUI		Configuration pages		

aaa-008087

**Fig 4. Memory organization NTAG213**

The structure of manufacturing data, lock bytes, capability container and user memory pages are compatible to NTAG203.

Page Adr		Byte number within a page				Description		
Dec	Hex	0	1	2	3			
0	0h					Manufacturer data and static lock bytes		
1	1h					Capability Container		
2	2h	serial number	internal	lock bytes	lock bytes			
3	3h	Capability Container (CC)						
4	4h	user memory						
5	5h							
...	...							
128	80h							
129	81h							
130	82h	dynamic lock bytes		RFUI		Dynamic lock bytes		
131	83h	CFG 0						
132	84h	CFG 1						
133	85h	PWD						
134	86h	PACK		RFUI		Configuration pages		

aaa-008088

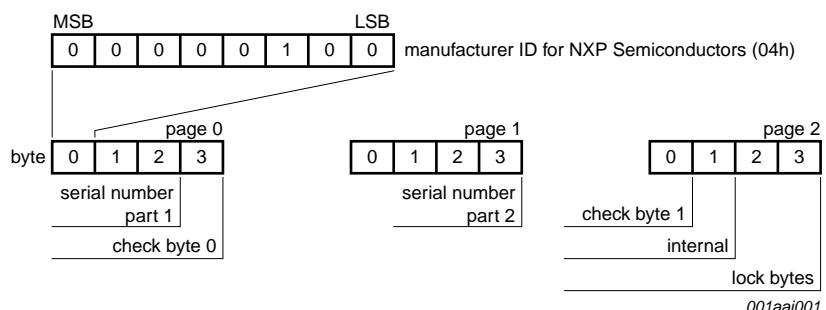
**Fig 5. Memory organization NTAG215**

Page Adr		Byte number within a page				Description		
Dec	Hex	0	1	2	3			
0	0h	serial number				Manufacturer data and static lock bytes		
1	1h	serial number				Capability Container		
2	2h	serial number	internal	lock bytes	lock bytes			
3	3h	Capability Container (CC)						
4	4h	user memory				User memory pages		
5	5h							
...	...							
224	E0h							
225	E1h							
226	E2h	dynamic lock bytes		RFUI		Dynamic lock bytes		
227	E3h	CFG 0						
228	E4h	CFG 1						
229	E5h	PWD						
230	E6h	PACK	RFUI			Configuration pages		

**Fig 6. Memory organization NTAG216**

### 8.5.1 UID/serial number

The unique 7-byte serial number (UID) and its two check bytes are programmed into the first 9 bytes of memory covering page addresses 00h, 01h and the first byte of page 02h. The second byte of page address 02h is reserved for internal data. These bytes are programmed and write protected in the production test.



**Fig 7. UID/serial number**

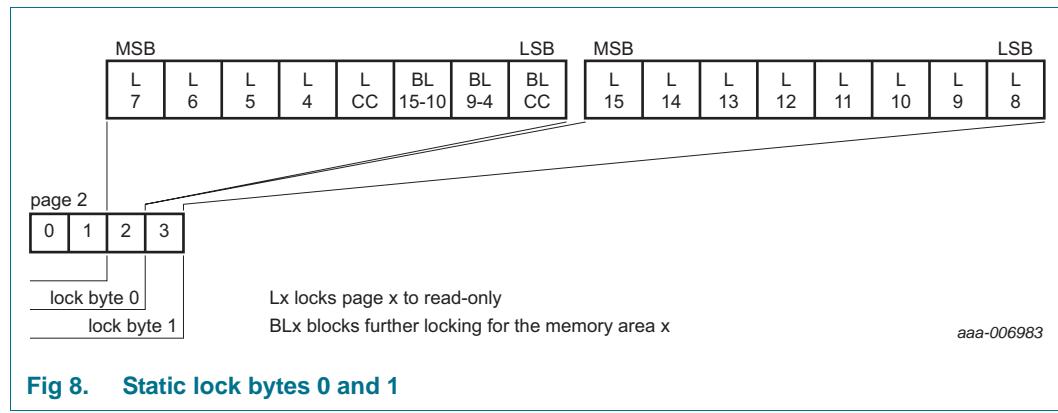
In accordance with ISO/IEC 14443-3 check byte 0 (BCC0) is defined as  $CT \oplus SN0 \oplus SN1 \oplus SN2$  and check byte 1 (BCC1) is defined as  $SN3 \oplus SN4 \oplus SN5 \oplus SN6$ .

SN0 holds the Manufacturer ID for NXP Semiconductors (04h) in accordance with ISO/IEC 14443-3.

### 8.5.2 Static lock bytes (NTAG21x)

The bits of byte 2 and byte 3 of page 02h represent the field programmable read-only locking mechanism. Each page from 03h (CC) to 0Fh can be individually locked by setting the corresponding locking bit Lx to logic 1 to prevent further write access. After locking, the corresponding page becomes read-only memory.

The three least significant bits of lock byte 0 are the block-locking bits. Bit 2 deals with pages 0Ah to 0Fh, bit 1 deals with pages 04h to 09h and bit 0 deals with page 03h (CC). Once the block-locking bits are set, the locking configuration for the corresponding memory area is frozen.



**Fig 8. Static lock bytes 0 and 1**

For example if BL15-10 is set to logic 1, then bits L15 to L10 (lock byte 1, bit[7:2]) can no longer be changed. The so called static locking and block-locking bits are set by a WRITE or COMPATIBILITY\_WRITE command to page 02h. Bytes 2 and 3 of the WRITE or COMPATIBILITY\_WRITE command, and the contents of the lock bytes are bit-wise OR'ed and the result then becomes the new content of the lock bytes. This process is irreversible. If a bit is set to logic 1, it cannot be changed back to logic 0.

The contents of bytes 0 and 1 of page 02h are unaffected by the corresponding data bytes of the WRITE or COMPATIBILITY WRITE command.

The default value of the static lock bytes is 00 00h.

Any write operation to the static lock bytes is tearing-proof.

### 8.5.3 Dynamic Lock Bytes

To lock the pages of NTAG21x starting at page address 10h and onwards, the so called dynamic lock bytes are used. The dynamic lock bytes are located at page 28h for NTAG213, at page 82h for NTAG215 and at page E2h for NTAG216. The three lock bytes cover the memory area of 96 data bytes for NTAG213, 456 data bytes for NTAG215 and 840 data bytes for NTAG216. The granularity is 2 pages for NTAG213 ([Figure 9](#)) and 16 pages for NTAG215 ([Figure 10](#)) and NTAG216 ([Figure 11](#)).

**Remark:** Set all bits marked with RFUI to 0, when writing to the dynamic lock bytes.

**Remark:** For the correct usage of the dynamic lock bytes with NFC devices for the NTAG215 and NTAG216 refer to [Ref. 8 “AN11456 NTAG21x Using the dynamic lock bits to lock the tag”](#).

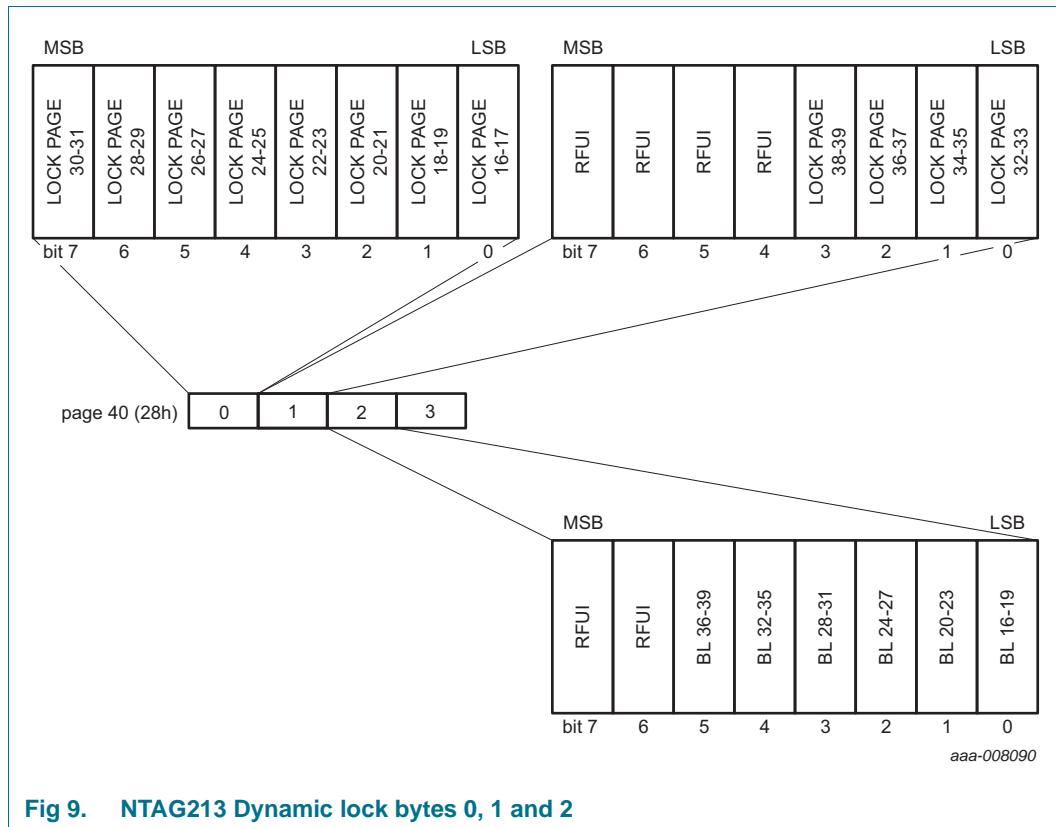


Fig 9. NTAG213 Dynamic lock bytes 0, 1 and 2

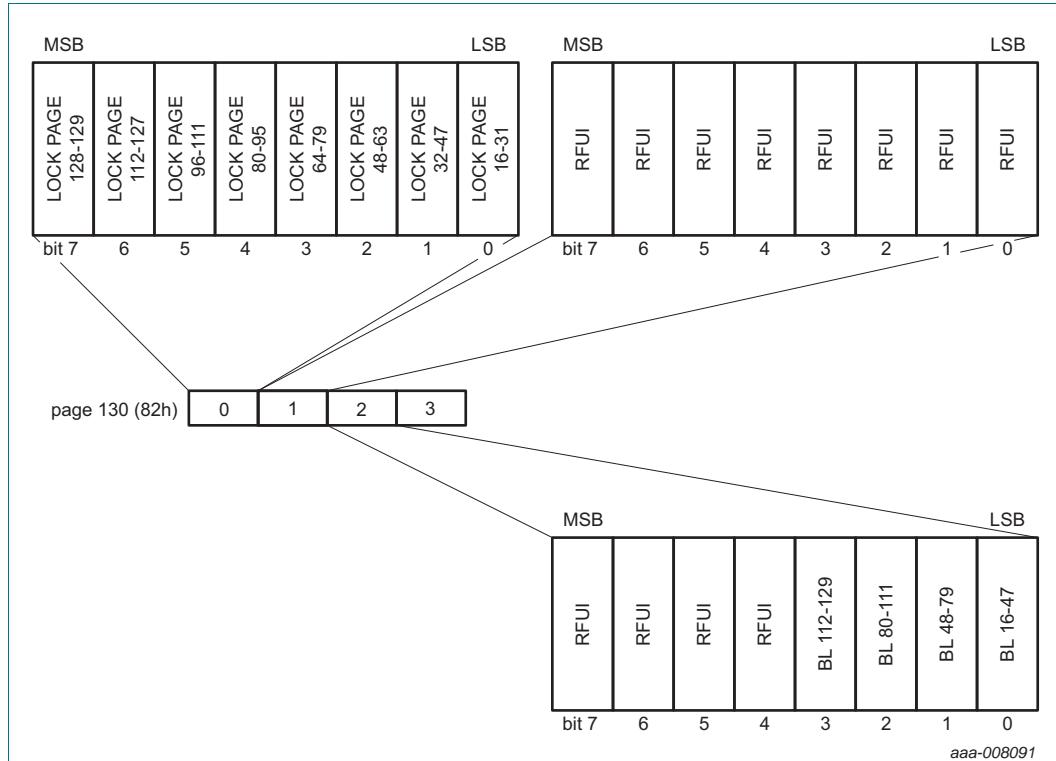
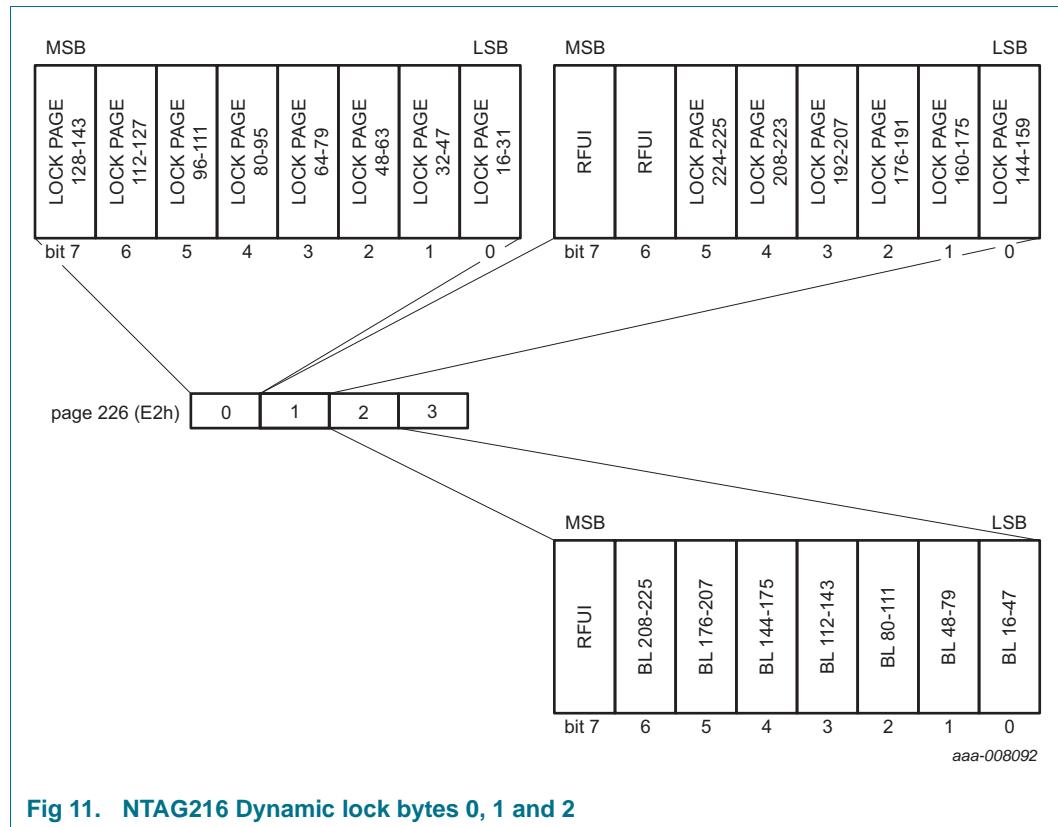


Fig 10. NTAG215 Dynamic lock bytes 0, 1 and 2



**Fig 11. NTAG216 Dynamic lock bytes 0, 1 and 2**

The default value of the dynamic lock bytes is 00 00 00h. The value of Byte 3 is always BDh when read.

Any write operation to the dynamic lock bytes is tearing-proof.

#### 8.5.4 Capability Container (CC bytes)

The Capability Container CC (page 3) is programmed during the IC production according to the NFC Forum Type 2 Tag specification (see [Ref. 2](#)). These bytes may be bit-wise modified by a WRITE or COMPATIBILITY\_WRITE command.

page 3				Example NTAG213			
byte	0	1	2	4	default value (initialized state)	CC bytes	
data	E1h	10h	12h	00	11100001	00010000	00010010
CC bytes							
write command to page 3							
	00000000	00000000	00000000	00001111			
result in page 3 (read-only state)							
	11100001	00010000	00010010	00001111			
aaa-008093							

**Fig 12. CC bytes example**

The parameter bytes of the WRITE command and the current contents of the CC bytes are bit-wise OR'ed. The result is the new CC byte contents. This process is irreversible and once a bit is set to logic 1, it cannot be changed back to logic 0.

Byte 2 in the capability container defines the available memory size for NDEF messages. The configuration at delivery is shown in [Table 4](#).

**Table 4. NDEF memory size**

IC	Value in byte 2	NDEF memory size
NTAG213	12h	144 byte
NTAG215	3Eh	496 byte
NTAG216	6Dh	872 byte

Any write operation to the CC bytes is tearing-proof.

The default values of the CC bytes at delivery are defined in [Section 8.5.6](#).

#### 8.5.5 Data pages

Pages 04h to 27h for NTAG213, pages 04h to 81h for NTAG215 and pages 04h to E1h for NTAG216 are the user memory read/write area.

The access to a part of the user memory area can be restricted using a password verification. See [Section 8.8](#) for further details.

The default values of the data pages at delivery are defined in [Section 8.5.6](#).

### 8.5.6 Memory content at delivery

The capability container in page 03h and the data pages 04h and 05h of NTAG21x are pre-programmed as defined in [Table 5](#), [Table 6](#) and [Table 7](#).

**Table 5. Memory content at delivery NTAG213**

Page Address	Byte number within page			
	0	1	2	3
03h	E1h	10h	12h	00h
04h	01h	03h	A0h	0Ch
05h	34h	03h	00h	FEh

**Table 6. Memory content at delivery NTAG215**

Page Address	Byte number within page			
	0	1	2	3
03h	E1h	10h	3Eh	00h
04h	03h	00h	FEh	00h
05h	00h	00h	00h	00h

**Table 7. Memory content at delivery NTAG216**

Page Address	Byte number within page			
	0	1	2	3
03h	E1h	10h	6Dh	00h
04h	03h	00h	FEh	00h
05h	00h	00h	00h	00h

The access to a part of the user memory area can be restricted using a password verification. Please see [Section 8.8](#) for further details.

**Remark:** The default content of the data pages from page 05h onwards is not defined at delivery.

**Remark:** For the correct usage of the dynamic lock bytes with NFC devices for the NTAG215 and NTAG216 refer to [Ref. 8 "AN11456 NTAG21x Using the dynamic lock bits to lock the tag"](#).

### 8.5.7 Configuration pages

Pages 29h to 2Ch for NTAG213, pages 83h to 86h for NTAG215 and pages E3h to E6h for NTAG216 are used to configure the memory access restriction and to configure the UID ASCII mirror feature. The memory content of the configuration pages is detailed below.

**Table 8. Configuration Pages**

Page Address <sup>[1]</sup>		Byte number			
Dec	Hex	0	1	2	3
41/131/ 227	29h/83h /E3h	MIRROR	RFUI	MIRROR_PAGE	AUTH0
42/132/ 228	2Ah/84 h/E4h	ACCESS	RFUI	RFUI	RFUI
43/133/ 229	2Bh/85 h/E5h		PWD		
44/134/ 230	2Ch/86 h/E6h	PACK	RFUI	RFUI	

[1] Page address for resp. NTAG213/NTAG215/NTAG216

**Table 9. MIRROR configuration byte**

Bit number								
7	6	5	4	3	2	1	0	
MIRROR_CONF		MIRROR_BYTE		RFUI	STRG_MOD_EN		RFUI	

**Table 10. ACCESS configuration byte**

Bit number								
7	6	5	4	3	2	1	0	
PROT	CFGLOCK	RFUI	NFC_CNT_EN	NFC_CNT_PWD_ROT			AUTHLIM	

**Table 11. Configuration parameter descriptions**

Field	Bit	Default values	Description
MIRROR_CONF	2	00b	Defines which ASCII mirror shall be used, if the ASCII mirror is enabled by a valid the MIRROR_PAGE byte 00b ... no ASCII mirror 01b ... UID ASCII mirror 10b ... NFC counter ASCII mirror 11b ... UID and NFC counter ASCII mirror
MIRROR_BYTE	2	00b	The 2 bits define the byte position within the page defined by the MIRROR_PAGE byte (beginning of ASCII mirror)
STRG_MOD_EN	1	1b	STRG MOD_EN defines the modulation mode 0b ... strong modulation mode disabled 1b ... strong modulation mode enabled

Table 11. Configuration parameter descriptions

Field	Bit	Default values	Description
MIRROR_PAGE	8	00h	MIRROR_Page defines the page for the beginning of the ASCII mirroring A value >03h enables the ASCII mirror feature
AUTH0	8	FFh	AUTH0 defines the page address from which the password verification is required. Valid address range for byte AUTH0 is from 00h to FFh. If AUTH0 is set to a page address which is higher than the last page from the user configuration, the password protection is effectively disabled.
PROT	1	0b	One bit inside the ACCESS byte defining the memory protection 0b ... write access is protected by the password verification 1b ... read and write access is protected by the password verification
CFGLOCK	1	0b	Write locking bit for the user configuration 0b ... user configuration open to write access 1b ... user configuration permanently locked against write access, except PWD and PACK
NFC_CNT_EN	1	0b	NFC counter configuration 0b ... NFC counter disabled 1b ... NFC counter enabled If the NFC counter is enabled, the NFC counter will be automatically increased at the first READ or FAST_READ command after a power on reset
NFC_CNT_PWD_PROT	1	0b	NFC counter password protection 0b ... NFC counter not protected 1b ... NFC counter password protection enabled If the NFC counter password protection is enabled, the NFC tag will only respond to a READ_CNT command with the NFC counter value after a valid password verification
AUTHLIM	3	000b	Limitation of negative password verification attempts 000b ... limiting of negative password verification attempts disabled 001b-111b ... maximum number of negative password verification attempts
PWD	32	FFFFFFFh	32-bit password used for memory access protection
PACK	16	0000h	16-bit password acknowledge used during the password verification process
RFUI	-	all 0b	Reserved for future use - implemented. Write all bits and bytes denoted as RFUI as 0b.

**Remark:** The CFGLOCK bit activates the permanent write protection of the first two configuration pages. The write lock is only activated after a power cycle of NTAG21x. If write protection is enabled, each write attempt leads to a NAK response.

## 8.6 NFC counter function

NTAG21x features a NFC counter function. This function enables NTAG21x to automatically increase the 24 bit counter value, triggered by the first valid

- READ command or
- FAST-READ command

after the NTAG21x tag is powered by an RF field.

Once the NFC counter has reached the maximum value of FF FF FF hex, the NFC counter value will not change any more.

The NFC counter is enabled or disabled with the NFC\_CNT\_EN bit (see [Section 8.5.7](#)).

The actual NFC counter value can be read with

- READ\_CNT command or
- NFC counter mirror feature

The reading of the NFC counter (by READ\_CNT command or with the NFC counter mirror) can also be protected with the password authentication. The NFC counter password protection is enabled or disabled with the NFC\_CNT\_PWD\_PROT bit (see [Section 8.5.7](#)).

## 8.7 ASCII mirror function

NTAG21x features a ASCII mirror function. This function enables NTAG21x to virtually mirror

- 7 byte UID (see [Section 8.7.1](#)) or
- 3 byte NFC counter value (see [Section 8.7.2](#)) or
- both, 7 byte UID and 3 byte NFC counter value with a separation byte (see [Section 8.7.3](#))

into the physical memory of the IC in ASCII code. On the READ or FAST READ command to the involved user memory pages, NTAG21x will respond with the virtual memory content of the UID and/or NFC counter value in ASCII code.

The required length of the reserved physical memory for the mirror functions is specified in [Table 12](#). If the ASCII mirror exceeds the user memory area, the data will not be mirrored.

**Table 12. Required memory space for ASCII mirror**

ASCII mirror	Required number of bytes in the physical memory
UID mirror	14 bytes
NFC counter	6 bytes
UID + NFC counter mirror	21 bytes (14 bytes for UID + 1 byte separation + 6 bytes NFC counter value)

The position within the user memory where the mirroring of the UID and/or NFC counter shall start is defined by the MIRROR\_PAGE and MIRROR\_BYTE values.

The MIRROR\_PAGE value defines the page where the ASCII mirror shall start and the MIRROR\_BYTE value defines the starting byte within the defined page.

The ASCII mirror function is enabled with a MIRROR\_PAGE value >03h.

The MIRROR\_CONF bits (see [Table 9](#) and [Table 11](#)) define if ASCII mirror shall be enabled for the UID and/or NFC counter.

If both, the UID and NFC counter, are enabled for the ASCII mirror, the UID and the NFC counter bytes are separated automatically with an “x” character (78h ASCII code).

### 8.7.1 UID ASCII mirror function

This function enables NTAG21x to virtually mirror the 7 byte UID in ASCII code into the physical memory of the IC. The length of the UID ASCII mirror requires 14 bytes to mirror the UID in ASCII code. On the READ or FAST READ command to the involved user memory pages, NTAG21x will respond with the virtual memory content of the UID in ASCII code.

The position within the user memory where the mirroring of the UID shall start is defined by the MIRROR\_PAGE and MIRROR\_BYTE values.

The MIRROR\_PAGE value defines the page where the UID ASCII mirror shall start and the MIRROR\_BYTE value defines the starting byte within the defined page.

The UID ASCII mirror function is enabled with a MIRROR\_PAGE value >03h and the MIRROR\_CONF bits are set to 01b.

**Remark:** Please note that the 14 bytes of the UID ASCII mirror shall not exceed the boundary of the user memory. Therefore it is required to use only valid values for MIRROR\_BYTE and MIRROR\_PAGE to ensure a proper functionality. If the UID ASCII mirror exceeds the user memory area, the UID will not be mirrored.

**Table 13. Configuration parameter description**

	MIRROR_PAGE	MIRROR_BYTE bits
Minimum values	04h	00b
Maximum values	last user memory page - 3	01b

### 8.7.1.1 UID ASCII Mirror example

[Table 14](#) show the memory content of a NTAG213 which has been written to the physical memory. Without the UID ASCII mirror feature, the content in the user memory would be a URL according to the NFC Data Exchange Format (NDEF) [Ref. 3](#) with the content:

<http://www.nxp.com/index.html?m=0000000000000000>

**Table 14. UID ASCII mirror - Physical memory content**

Page address		Byte number				
dec.	hex.	0	1	2	3	ASCII
0	00h	04	E1	41	2C	
1	01h	12	4C	28	80	
2	02h	F6	internal		lock bytes	
3	03h	E1	10	12	00	
4	04h	01	03	A0	0C	....
5	05h	34	03	28	D1	4.(.
6	06h	01	24	55	01	.\$U.
7	07h	6E	78	70	2E	nxp.
8	08h	63	6F	6D	2F	com/
9	09h	69	6E	64	65	inde
10	0Ah	78	2E	68	74	x.ht
11	0Bh	6D	6C	3F	6D	ml?m
12	0Ch	3D	30	30	30	=000
13	0Dh	30	30	30	30	0000
14	0Eh	30	30	30	30	0000
15	0Fh	30	30	30	FE	000.
16	10h	00	00	00	00	....
...	...					
39	27h	00	00	00	00	....
40	28h		dynamic lock bytes		RFUI	
41	29h	54	RFUI	0C	AUTH0	
42	2Ah	Access				
43	2Bh			PWD		
44	2Ch		PACK		RFUI	

With the UID Mirror feature and the related values in the MIRROR\_PAGE and the MIRROR\_BYTE the UID 04-E1-41-12-4C-28-80h will be mirrored in ASCII code into the user memory starting in page 0Ch byte 1. The virtual memory content is shown in [Table 15](#).

Reading the user memory, the data will be returned as an URL according to the NFC Data Exchange Format (NDEF) [Ref. 3](#) with the content:

<http://www.nxp.com/index.html?m=04E141124C2880>

**Table 15. UID ASCII mirror - Virtual memory content**

Page address		Byte number				ASCII
dec.	hex.	0	1	2	3	
0	00h	04	E1	41	2C	
1	01h	12	4C	28	80	
2	02h	F6	internal		lock bytes	
3	03h	E1	10	12	00	
4	04h	01	03	A0	0C	....
5	05h	34	03	28	D1	4.(.
6	06h	01	24	55	01	.\$U.
7	07h	6E	78	70	2E	nxp.
8	08h	63	6F	6D	2F	com/
9	09h	69	6E	64	65	inde
10	0Ah	78	2E	68	74	x.ht
11	0Bh	6D	6C	3F	6D	ml?m
12	0Ch	3D	30	34	45	=04E
13	0Dh	31	34	31	31	1411
14	0Eh	32	34	43	32	24C2
15	0Fh	38	38	30	FE	880.
16	10h	00	00	00	00	....
...	...					
39	27h	00	00	00	00	....
40	28h		dynamic lock bytes		RFUI	
41	29h	54	RFUI	0C	AUTH0	
42	2Ah	Access				
43	2Bh			PWD		
44	2Ch		PACK		RFUI	

### 8.7.2 NFC counter mirror function

This function enables NTAG21x to virtually mirror the 3 byte NFC counter value in ASCII code into the physical memory of the IC. The length of the NFC counter mirror requires 6 bytes to mirror the NFC counter value in ASCII code. On the READ or FAST READ command to the involved user memory pages, NTAG21x will respond with the virtual memory content of the NFC counter in ASCII code.

The position within the user memory where the mirroring of the NFC counter shall start is defined by the MIRROR\_PAGE and MIRROR\_BYTE values.

The MIRROR\_PAGE value defines the page where the NFC counter mirror shall start and the MIRROR\_BYTE value defines the starting byte within the defined page.

The NFC counter mirror function is enabled with a MIRROR\_PAGE value >03h and the MIRROR\_CONF bits are set to 10b.

If the NFC counter is password protected with the NFC\_CNT\_PWD\_PROT bit set to 1b (see [Section 8.5.7](#)), the NFC counter will only be mirrored into the physical memory, if a valid password authentication has been executed before.

**Remark:** To enable the NFC counter itself (see [Section 8.6](#)), the NFC\_CNT\_EN bit shall be set to 1b.

**Remark:** Please note that the 6 bytes of the NFC counter mirror shall not exceed the boundary of the user memory. Therefore it is required to use only valid values for MIRROR\_BYTE and MIRROR\_PAGE to ensure a proper functionality. If the NFC counter mirror exceeds the user memory area, the NFC counter will not be mirrored.

**Table 16. Configuration parameter description**

	MIRROR_PAGE	MIRROR_BYTE bits
Minimum values	04h	00b
Maximum values	last user memory page - 1	01b

### 8.7.2.1 NFC counter mirror example

[Table 17](#) show the memory content of a NTAG213 which has been written to the physical memory. Without the NFC counter mirror feature, the content in the user memory would be a URL according to the NFC Data Exchange Format (NDEF) [Ref. 3](#) with the content:

<http://www.nxp.com/index.html?m=000000>

**Table 17. NFC counter mirror - Physical memory content**

Page address		Byte number				
dec.	hex.	0	1	2	3	ASCII
0	00h	04	E1	41	2C	
1	01h	12	4C	28	80	
2	02h	F6	internal		lock bytes	
3	03h	E1	10	12	00	
4	04h	01	03	A0	0C	....
5	05h	34	03	20	D1	4.(.
6	06h	01	1C	55	01	.\$U.
7	07h	6E	78	70	2E	nxp.
8	08h	63	6F	6D	2F	com/
9	09h	69	6E	64	65	inde
10	0Ah	78	2E	68	74	x.ht
11	0Bh	6D	6C	3F	6D	ml?m
12	0Ch	3D	30	30	30	=000
13	0Dh	30	30	30	FE	000.
14	0Eh	00	00	00	00	....
...	...					
39	27h	00	00	00	00	....
40	28h		dynamic lock bytes		RFUI	
41	29h	94	RFUI	0C	AUTH0	
42	2Ah	Access				
43	2Bh			PWD		
44	2Ch		PACK		RFUI	

With the NFC counter mirror feature and the related values in the MIRROR\_PAGE and the MIRROR\_BYTE the NFC counter value of e.g. 00-3F-31h will be mirrored in ASCII code into the user memory starting in page 0Ch byte 1. The virtual memory content is shown in [Table 18](#).

Reading the user memory, the data will be returned as an URL according to the NFC Data Exchange Format (NDEF) [Ref. 3](#) with the content:

<http://www.nxp.com/index.html?m=003F31>

**Table 18. NFC counter mirror - Virtual memory content**

Page address		Byte number					ASCII
dec.	hex.	0	1	2	3		
0	00h	04	E1	41	2C		
1	01h	12	4C	28	80		
2	02h	F6	internal		lock bytes		
3	03h	E1	10	12	00		
4	04h	01	03	A0	0C	....	
5	05h	34	03	20	D1	4.(.	
6	06h	01	1C	55	01	.\$U.	
7	07h	6E	78	70	2E	nxp.	
8	08h	63	6F	6D	2F	com/	
9	09h	69	6E	64	65	inde	
10	0Ah	78	2E	68	74	x.ht	
11	0Bh	6D	6C	3F	6D	ml?m	
12	0Ch	3D	30	30	33	=003	
13	0Dh	46	33	31	FE	F31.	
14	0Eh	00	00	00	00	....	
...	...						
39	27h	00	00	00	00	....	
40	28h		dynamic lock bytes		RFUI		
41	29h	94	RFUI	0C	AUTH0		
42	2Ah	Access					
43	2Bh			PWD			
44	2Ch		PACK		RFUI		

### 8.7.3 UID and NFC counter mirror function

This function enables NTAG21x to virtually mirror the 7 byte UID and 3 byte NFC counter value in ASCII code into the physical memory of the IC separated by 1 byte ("x" character, 78h). The length of the mirror requires 21 bytes to mirror the UID, NFC counter value and the separation byte in ASCII code. On the READ or FAST READ command to the involved user memory pages, NTAG21x will respond with the virtual memory content of the UID and NFC counter in ASCII code.

The position within the user memory where the mirroring shall start is defined by the MIRROR\_PAGE and MIRROR\_BYTE values.

The MIRROR\_PAGE value defines the page where the mirror shall start and the MIRROR\_BYTE value defines the starting byte within the defined page.

The UID and NFC counter mirror function is enabled with a MIRROR\_PAGE value >03h and the MIRROR\_CONF bits are set to 11b.

If the NFC counter is password protected with the NFC\_CNT\_PWD\_PROT bit set to 1b (see [Section 8.5.7](#)), the NFC counter will only be mirrored into the physical memory, if a valid password authentication has been executed before.

**Remark:** To enable the NFC counter itself (see [Section 8.6](#)), the NFC\_CNT\_EN bit shall be set to 1b.

**Remark:** Please note that the 21 bytes of the UID and NFC counter mirror shall not exceed the boundary of the user memory. Therefore it is required to use only valid values for MIRROR\_BYTE and MIRROR\_PAGE to ensure a proper functionality. If the UID and NFC counter mirror exceeds the user memory area, the UID and NFC counter will not be mirrored.

**Table 19. Configuration parameter description**

	MIRROR_PAGE	MIRROR_BYTE bits
Minimum values	04h	00b
Maximum values	last user memory page - 5	10b

### 8.7.3.1 UID and NFC counter mirror example

[Table 20](#) show the memory content of a NTAG213 which has been written to the physical memory. Without the UID ASCII mirror feature, the content in the user memory would be a URL according to the NFC Data Exchange Format (NDEF) [Ref. 3](#) with the content:

<http://www.nxp.com/index.html?m=0000000000000000x000000>

**Table 20. UID and NFC counter ASCII mirror - Physical memory content**

Page address		Byte number				
dec.	hex.	0	1	2	3	ASCII
0	00h	04	E1	41	2C	
1	01h	12	4C	28	80	
2	02h	F6	internal		lock bytes	
3	03h	E1	10	12	00	
4	04h	01	03	A0	0C	....
5	05h	34	03	2F	D1	4.(.
6	06h	01	2B	55	01	.\$U.
7	07h	6E	78	70	2E	nxp.
8	08h	63	6F	6D	2F	com/
9	09h	69	6E	64	65	inde
10	0Ah	78	2E	68	74	x.ht
11	0Bh	6D	6C	3F	6D	ml?m
12	0Ch	3D	30	30	30	=000
13	0Dh	30	30	30	30	0000
14	0Eh	30	30	30	30	0000
15	0Fh	30	30	30	78	000x
16	10h	30	30	30	30	0000
17	11h	30	30	FE	00	00..
18	12h	00	00	00	00	....
...	...					
39	27h	00	00	00	00	....
40	28h		dynamic lock bytes		RFUI	
41	29h	D4	RFUI	0C	AUTH0	
42	2Ah	Access				
43	2Bh			PWD		
44	2Ch		PACK		RFUI	

With the UID Mirror feature and the related values in the MIRROR\_PAGE and the MIRROR\_BYTE the UID 04-E1-41-12-4C-28-80h and the NFC counter value of e.g. 00-3F-31h will be mirrored in ASCII code into the user memory starting in page 0Ch byte 1. The virtual memory content is shown in [Table 21](#).

**Remark:** Please note that the separation character "x" (78h) is automatically mirrored between the UID mirror and the NFC counter mirror.

Reading the user memory, the data will be returned as an URL according to the NFC Data Exchange Format (NDEF) [Ref. 3](#) with the content:

<http://www.nxp.com/index.html?m=04E141124C2880x003F31>

**Table 21. UID and NFC counter ASCII mirror - Physical memory content**

Page address		Byte number					
dec.	hex.	0	1	2	3	ASCII	
0	00h	04	E1	41	2C		
1	01h	12	4C	28	80		
2	02h	F6	internal		lock bytes		
3	03h	E1	10	12	00		
4	04h	01	03	A0	0C	....	
5	05h	34	03	2F	D1	4.(.	
6	06h	01	2B	55	01	.\$U.	
7	07h	6E	78	70	2E	nxp.	
8	08h	63	6F	6D	2F	com/	
9	09h	69	6E	64	65	inde	
10	0Ah	78	2E	68	74	x.ht	
11	0Bh	6D	6C	3F	6D	ml?m	
12	0Ch	3D	30	34	45	=04E	
13	0Dh	31	34	31	31	1411	
14	0Eh	32	34	43	32	24C2	
15	0Fh	38	38	30	78	880x	
16	10h	30	30	33	46	003F	
17	11h	33	31	FE	00	31..	
18	12h	00	00	00	00	....	
...	...						
39	27h	00	00	00	00	....	
40	28h		dynamic lock bytes		RFUI		
41	29h	D4	RFUI	0C	AUTH0		
42	2Ah	Access					
43	2Bh			PWD			
44	2Ch		PACK		RFUI		

## 8.8 Password verification protection

The memory write or read/write access to a configurable part of the memory can be constrained by a positive password verification. The 32-bit secret password (PWD) and the 16-bit password acknowledge (PACK) response are typically programmed into the configuration pages at the tag personalization stage.

The AUTHLIM parameter specified in [Section 8.5.7](#) can be used to limit the negative verification attempts.

In the initial state of NTAG21x, password protection is disabled by a AUTH0 value of FFh. PWD and PACK are freely writable in this state. Access to the configuration pages and any part of the user memory can be restricted by setting AUTH0 to a page address within the available memory space. This page address is the first one protected.

**Remark:** The password protection method provided in NTAG21x has to be intended as an easy and convenient way to prevent unauthorized memory accesses. If a higher level of protection is required, cryptographic methods can be implemented at application layer to increase overall system security.

### 8.8.1 Programming of PWD and PACK

The 32-bit PWD and the 16-bit PACK need to be programmed into the configuration pages, see [Section 8.5.7](#). The password as well as the password acknowledge are written LSByte first. This byte order is the same as the byte order used during the PWD\_AUTH command and its response.

The PWD and PACK bytes can never be read out of the memory. Instead of transmitting the real value on any valid READ or FAST\_READ command, only 00h bytes are replied.

If the password verification does not protect the configuration pages, PWD and PACK can be written with normal WRITE and COMPATIBILITY\_WRITE commands.

If the configuration pages are protected by the password configuration, PWD and PACK can be written after a successful PWD\_AUTH command.

The PWD and PACK are writable even if the CFGLOCK bit is set to 1b. Therefore it is strongly recommended to set AUTH0 to the page where the PWD is located after the password has been written. This page is 2Bh for NTAG213, page 85h for NTAG215 and page E5h for NTAG216.

**Remark:** To improve the overall system security, it is advisable to diversify the password and the password acknowledge using a die individual parameter of the IC, that is the 7-byte UID available on NTAG21x.

### 8.8.2 Limiting negative verification attempts

To prevent brute-force attacks on the password, the maximum allowed number of negative password verification attempts can be set using AUTHLIM. This mechanism is disabled by setting AUTHLIM to a value of 000b, which is also the initial state of NTAG21x.

If AUTHLIM is not equal to 000b, each negative authentication verification is internally counted. The count operation features anti-tearing support. As soon as this internal counter reaches the number specified in AUTHLIM, any further negative password verification leads to a permanent locking of the protected part of the memory for the specified access modes. Specifically, whether the provided password is correct or not, each subsequent PWD\_AUTH fails.

Any successful password verification, before reaching the limit of negative password verification attempts, resets the internal counter to zero.

### 8.8.3 Protection of special memory segments

The configuration pages can be protected by the password authentication as well. The protection level is defined with the PROT bit.

The protection is enabled by setting the AUTH0 byte to a value that is within the addressable memory space.

## 8.9 Originality signature

NTAG21x features a cryptographically supported originality check. With this feature, it is possible to verify with a certain confidence that the tag is using an IC manufactured by NXP Semiconductors. This check can be performed on personalized tags as well.

NTAG21x digital signature is based on standard Elliptic Curve Cryptography (curve name *secp128r1*), according to the ECDSA algorithm. The use of a standard algorithm and curve ensures easy software integration of the originality check procedure in NFC devices without specific hardware requirements.

Each NTAG21x UID is signed with a NXP private key and the resulting 32-byte signature is stored in a hidden part of the NTAG21x memory during IC production.

This signature can be retrieved using the READ\_SIG command and can be verified in the NFC device by using the corresponding ECC public key provided by NXP. In case the NXP public key is stored in the NFC device, the complete signature verification procedure can be performed offline.

To verify the signature (for example with the use of the public domain crypto library *OpenSSL*) the tool domain parameters shall be set to *secp128r1*, defined within the standards for elliptic curve cryptography SEC ([Ref. 7](#)).

Details on how to check the signature value are provided in following application note ([Ref. 5](#)). It is foreseen to offer an online and offline way to verify originality of NTAG21x.

## 9. Command overview

NTAG activation follows the ISO/IEC 14443 Type A. After NTAG21x has been selected, it can either be deactivated using the ISO/IEC 14443 HLTA command, or the NTAG commands (e.g. READ or WRITE) can be performed. For more details about the card activation refer to [Ref. 1](#).

### 9.1 NTAG21x command overview

All available commands for NTAG21x are shown in [Table 22](#).

**Table 22. Command overview**

Command <sup>[1]</sup>	ISO/IEC 14443	NFC FORUM	Command code (hexadecimal)
Request	REQA	SENS_REQ	26h (7 bit)
Wake-up	WUPA	ALL_REQ	52h (7 bit)
Anticollision CL1	Anticollision CL1	SDD_REQ CL1	93h 20h
Select CL1	Select CL1	SEL_REQ CL1	93h 70h
Anticollision CL2	Anticollision CL2	SDD_REQ CL2	95h 20h
Select CL2	Select CL2	SEL_REQ CL2	95h 70h
Halt	HLTA	SLP_REQ	50h 00h
GET_VERSION <sup>[2]</sup>	-	-	60h
READ	-	READ	30h
FAST_READ <sup>[2]</sup>	-	-	3Ah
WRITE	-	WRITE	A2h
COMP_WRITE	-	-	A0h
READ_CNT <sup>[2]</sup>	-	-	39h
PWD_AUTH <sup>[2]</sup>	-	-	1Bh
READ_SIG <sup>[2]</sup>	-	-	3Ch

[1] Unless otherwise specified, all commands use the coding and framing as described in [Ref. 1](#).

[2] This command is new in NTAG21x compared to NTAG203.

### 9.2 Timings

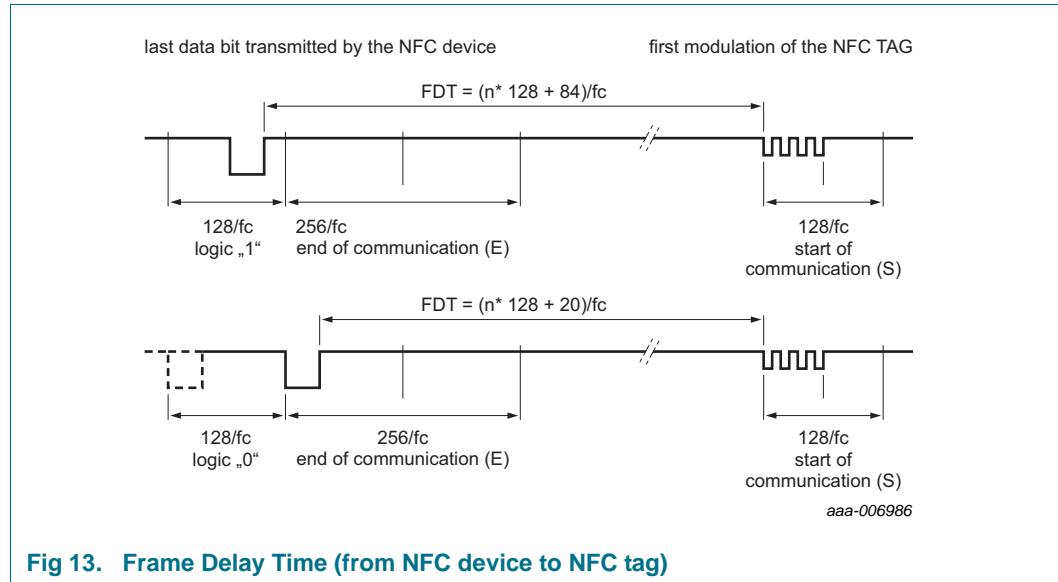
The command and response timings shown in this document are not to scale and values are rounded to 1  $\mu$ s.

All given command and response transmission times refer to the data frames including start of communication and end of communication. They do not include the encoding (like the Miller pulses). A NFC device data frame contains the start of communication (1 “start bit”) and the end of communication (one logic 0 + 1 bit length of unmodulated carrier). A NFC tag data frame contains the start of communication (1 “start bit”) and the end of communication (1 bit length of no subcarrier).

The minimum command response time is specified according to [Ref. 1](#) as an integer  $n$  which specifies the NFC device to NFC tag frame delay time. The frame delay time from NFC tag to NFC device is at least 87  $\mu$ s. The maximum command response time is specified as a time-out value. Depending on the command, the  $T_{ACK}$  value specified for command responses defines the NFC device to NFC tag frame delay time. It does it for

either the 4-bit ACK value specified in [Section 9.3](#) or for a data frame.

All command timings are according to ISO/IEC 14443-3 frame specification as shown for the Frame Delay Time in [Figure 13](#). For more details refer to [Ref. 1](#).



**Remark:** Due to the coding of commands, the measured timings usually excludes (a part of) the end of communication. Considered this factor when comparing the specified with the measured times.

### 9.3 NTAG ACK and NAK

NTAG uses a 4 bit ACK / NAK as shown in [Table 23](#).

**Table 23. ACK and NAK values**

Code (4-bit)	ACK/NAK
Ah	Acknowledge (ACK)
0h	NAK for invalid argument (i.e. invalid page address)
1h	NAK for parity or CRC error
4h	NAK for invalid authentication counter overflow
5h	NAK for EEPROM write error

## 9.4 ATQA and SAK responses

NTAG21x replies to a REQA or WUPA command with the ATQA value shown in [Table 24](#). It replies to a Select CL2 command with the SAK value shown in [Table 25](#). The 2-byte ATQA value is transmitted with the least significant byte first (44h).

**Table 24. ATQA response of the NTAG21x**

Sales type	Hex value	Bit number															
		16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1
NTAG21x	00 44h	0	0	0	0	0	0	0	0	0	1	0	0	0	1	0	0

**Table 25. SAK response of the NTAG21x**

Sales type	Hex value	Bit number							
		8	7	6	5	4	3	2	1
NTAG21x	00h	0	0	0	0	0	0	0	0

**Remark:** The ATQA coding in bits 7 and 8 indicate the UID size according to ISO/IEC 14443 independent from the settings of the UID usage.

**Remark:** The bit numbering in the ISO/IEC 14443 starts with LSB = bit 1 and not with LSB = bit 0. So 1 byte counts bit 1 to bit 8 instead of bit 0 to 7.

## 10. NTAG commands

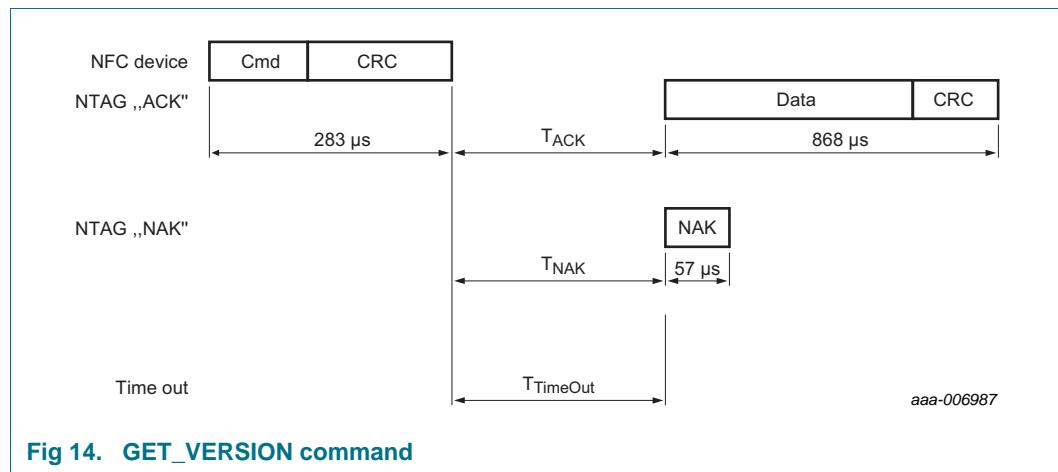
### 10.1 GET\_VERSION

The GET\_VERSION command is used to retrieve information on the NTAG family, the product version, storage size and other product data required to identify the specific NTAG21x.

This command is also available on other NTAG products to have a common way of identifying products across platforms and evolution steps.

The GET\_VERSION command has no arguments and replies the version information for the specific NTAG21x type. The command structure is shown in [Figure 14](#) and [Table 26](#).

[Table 27](#) shows the required timing.



**Fig 14. GET\_VERSION command**

**Table 26. GET\_VERSION command**

Name	Code	Description	Length
Cmd	60h	Get product version	1 byte
CRC	-	CRC according to <a href="#">Ref. 1</a>	2 bytes
Data	-	Product version information	8 bytes
NAK	see <a href="#">Table 23</a>	see <a href="#">Section 9.3</a>	4-bit

**Table 27. GET\_VERSION timing**

These times exclude the end of communication of the NFC device.

	TACK/NAK min	TACK/NAK max	TTimeOut
GET_VERSION	n=9 <sup>[1]</sup>	TTimeOut	5 ms

[1] Refer to [Section 9.2 "Timings"](#).

**Table 28. GET\_VERSION response for NTAG213, NTAG215 and NTAG216**

Byte no.	Description	NTAG213	NTAG215	NTAG216	Interpretation
0	fixed Header	00h	00h	00h	
1	vendor ID	04h	04h	04h	NXP Semiconductors
2	product type	04h	04h	04h	NTAG
3	product subtype	02h	02h	02h	50 pF
4	major product version	01h	01h	01h	1
5	minor product version	00h	00h	00h	V0
6	storage size	0Fh	11h	13h	see following information
7	protocol type	03h	03h	03h	ISO/IEC 14443-3 compliant

The most significant 7 bits of the storage size byte are interpreted as a unsigned integer value n. As a result, it codes the total available user memory size as  $2^n$ . If the least significant bit is 0b, the user memory size is exactly  $2^n$ . If the least significant bit is 1b, the user memory size is between  $2^n$  and  $2^{n+1}$ .

The user memory for NTAG213 is 144 bytes. This memory size is between 128bytes and 256 bytes. Therefore, the most significant 7 bits of the value 0Fh, are interpreted as 7d and the least significant bit is 1b.

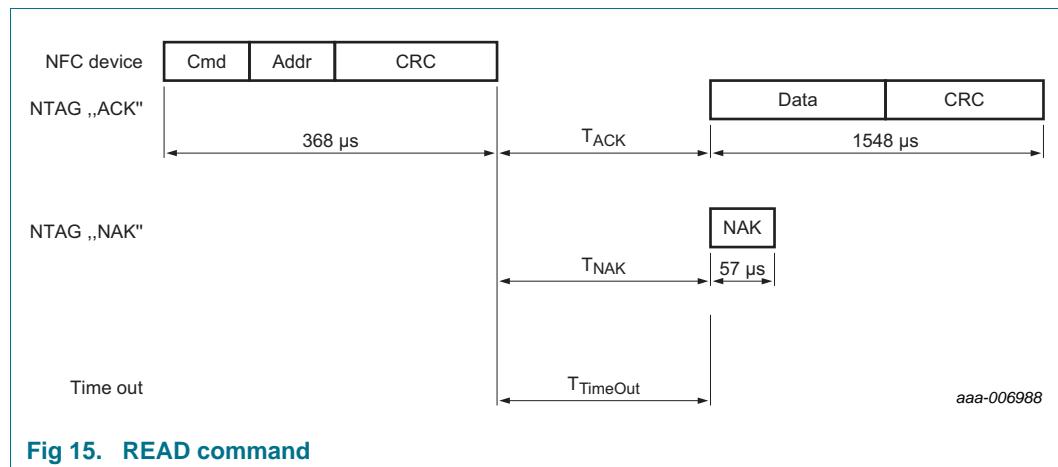
The user memory for NTAG215 is 504 bytes. This memory size is between 256 bytes and 512 bytes. Therefore, the most significant 7 bits of the value 11h, are interpreted as 8d and the least significant bit is 1b.

The user memory for NTAG216 is 888 bytes. This memory size is between 512 bytes and 1024 bytes. Therefore, the most significant 7 bits of the value 13h, are interpreted as 9d and the least significant bit is 1b.

## 10.2 READ

The READ command requires a start page address, and returns the 16 bytes of four NTAG21x pages. For example, if address (Addr) is 03h then pages 03h, 04h, 05h, 06h are returned. Special conditions apply if the READ command address is near the end of the accessible memory area. The special conditions also apply if at least part of the addressed pages is within a password protected area. For details on those cases and the command structure refer to [Figure 15](#) and [Table 29](#).

[Table 30](#) shows the required timing.



**Fig 15. READ command**

**Table 29. READ command**

Name	Code	Description	Length
Cmd	30h	read four pages	1 byte
Addr	-	start page address	1 byte
CRC	-	CRC according to <a href="#">Ref. 1</a>	2 bytes
Data	-	Data content of the addressed pages	16 bytes
NAK	see <a href="#">Table 23</a>	see <a href="#">Section 9.3</a>	4-bit

**Table 30. READ timing**

These times exclude the end of communication of the NFC device.

	T <sub>ACK/NAK min</sub>	T <sub>ACK/NAK max</sub>	T <sub>TimeOut</sub>
READ	n=9 <sup>[1]</sup>	T <sub>TimeOut</sub>	5 ms

[1] Refer to [Section 9.2 "Timings"](#).

In the initial state of NTAG21x, all memory pages are allowed as Addr parameter to the READ command.

- page address 00h to 2Ch for NTAG213
- page address 00h to 86h for NTAG215
- page address 00h to E6h for NTAG216

Addressing a memory page beyond the limits above results in a NAK response from NTAG21x.

A roll-over mechanism is implemented to continue reading from page 00h once the end of the accessible memory is reached. Reading from address 2Ah on a NTAG213 results in pages 2Ah, 2Bh, 2Ch and 00h being returned.

The following conditions apply if part of the memory is password protected for read access:

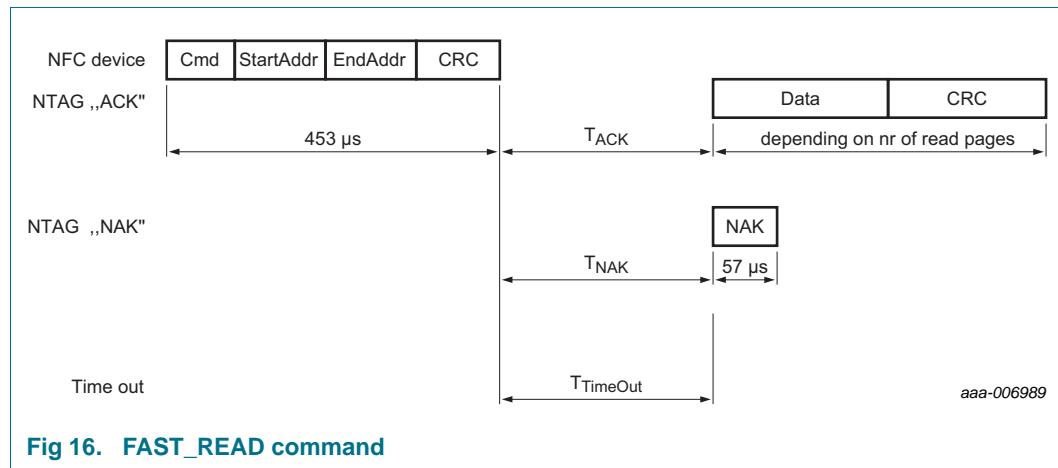
- if NTAG21x is in the ACTIVE state
  - addressing a page which is equal or higher than AUTH0 results in a NAK response
  - addressing a page lower than AUTH0 results in data being returned with the roll-over mechanism occurring just before the AUTH0 defined page
- if NTAG21x is in the AUTHENTICATED state
  - the READ command behaves like on a NTAG21x without access protection

**Remark:** PWD and PACK values can never be read out of the memory. When reading from the pages holding those two values, all 00h bytes are replied to the NFC device instead.

### 10.3 FAST\_READ

The FAST\_READ command requires a start page address and an end page address and returns the all  $n^*4$  bytes of the addressed pages. For example if the start address is 03h and the end address is 07h then pages 03h, 04h, 05h, 06h and 07h are returned. If the addressed page is outside of accessible area, NTAG21x replies a NAK. For details on those cases and the command structure, refer to [Figure 16](#) and [Table 31](#).

[Table 32](#) shows the required timing.



**Table 31. FAST\_READ command**

Name	Code	Description	Length
Cmd	3Ah	read multiple pages	1 byte
StartAddr	-	start page address	1 byte
EndAddr	-	end page address	1 byte
CRC	-	CRC according to <a href="#">Ref. 1</a>	2 bytes
Data	-	data content of the addressed pages	$n^*4$ bytes
NAK	see <a href="#">Table 23</a>	see <a href="#">Section 9.3</a>	4-bit

**Table 32. FAST\_READ timing**

These times exclude the end of communication of the NFC device.

	T <sub>ACK/NAK min</sub>	T <sub>ACK/NAK max</sub>	T <sub>TimeOut</sub>
FAST_READ	n=9 <sup>[1]</sup>	T <sub>TimeOut</sub>	5 ms

[1] Refer to [Section 9.2 "Timings"](#).

In the initial state of NTAG21x, all memory pages are allowed as StartAddr parameter to the FAST\_READ command.

- page address 00h to 2Ch for NTAG213
- page address 00h to 86h for NTAG215
- page address 00h to E6h for NTAG216

Addressing a memory page beyond the limits above results in a NAK response from NTAG21x.

The EndAddr parameter must be equal to or higher than the StartAddr.

The following conditions apply if part of the memory is password protected for read access:

- if NTAG21x is in the ACTIVE state
  - if any requested page address is equal or higher than AUTH0 a NAK is replied
- if NTAG21x is in the AUTHENTICATED state
  - the FAST\_READ command behaves like on a NTAG21x without access protection

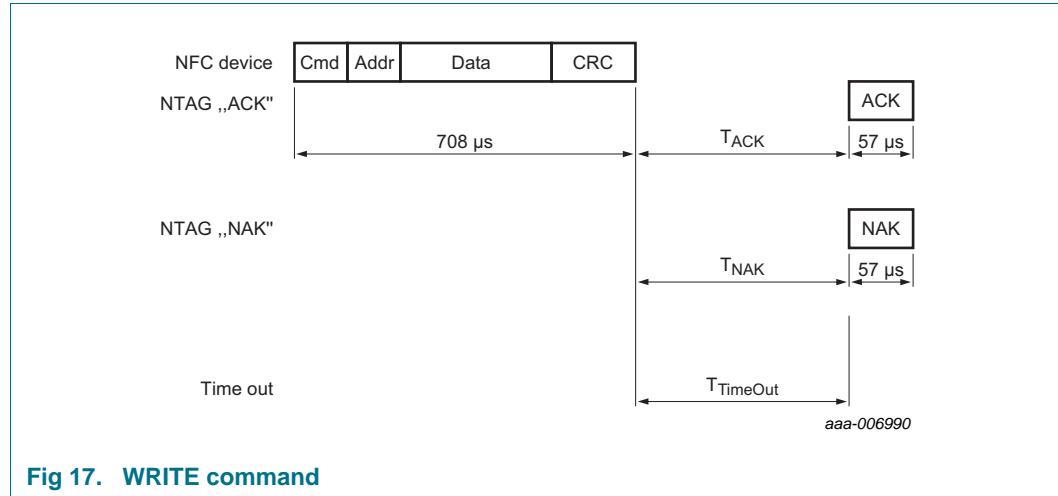
**Remark:** PWD and PACK values can never be read out of the memory. When reading from the pages holding those two values, all 00h bytes are replied to the NFC device instead.

**Remark:** The FAST\_READ command is able to read out the whole memory with one command. Nevertheless, receive buffer of the NFC device must be able to handle the requested amount of data as there is no chaining possibility.

## 10.4 WRITE

The WRITE command requires a block address, and writes 4 bytes of data into the addressed NTAG21x page. The WRITE command is shown in [Figure 17](#) and [Table 33](#).

[Table 34](#) shows the required timing.



**Fig 17. WRITE command**

**Table 33. WRITE command**

Name	Code	Description	Length
Cmd	A2h	write one page	1 byte
Addr	-	page address	1 byte
CRC	-	CRC according to <a href="#">Ref. 1</a>	2 bytes
Data	-	data	4 bytes
NAK	see <a href="#">Table 23</a>	see <a href="#">Section 9.3</a>	4-bit

**Table 34. WRITE timing**

These times exclude the end of communication of the NFC device.

	$T_{ACK/NAK \min}$	$T_{ACK/NAK \max}$	$T_{TimeOut}$
WRITE	$n=9$ <sup>[1]</sup>	$T_{TimeOut}$	10 ms

[1] Refer to [Section 9.2 "Timings"](#).

In the initial state of NTAG21x, the following memory pages are valid Addr parameters to the WRITE command.

- page address 02h to 2Ch for NTAG213
- page address 02h to 86h for NTAG215
- page address 02h to E6h for NTAG216

Addressing a memory page beyond the limits above results in a NAK response from NTAG21x.

Pages which are locked against writing cannot be reprogrammed using any write command. The locking mechanisms include static and dynamic lock bits as well as the locking of the configuration pages.

The following conditions apply if part of the memory is password protected for write access:

- if NTAG21x is in the ACTIVE state
  - writing to a page which address is equal or higher than AUTH0 results in a NAK response
- if NTAG21x is in the AUTHENTICATED state
  - the WRITE command behaves like on a NTAG21x without access protection

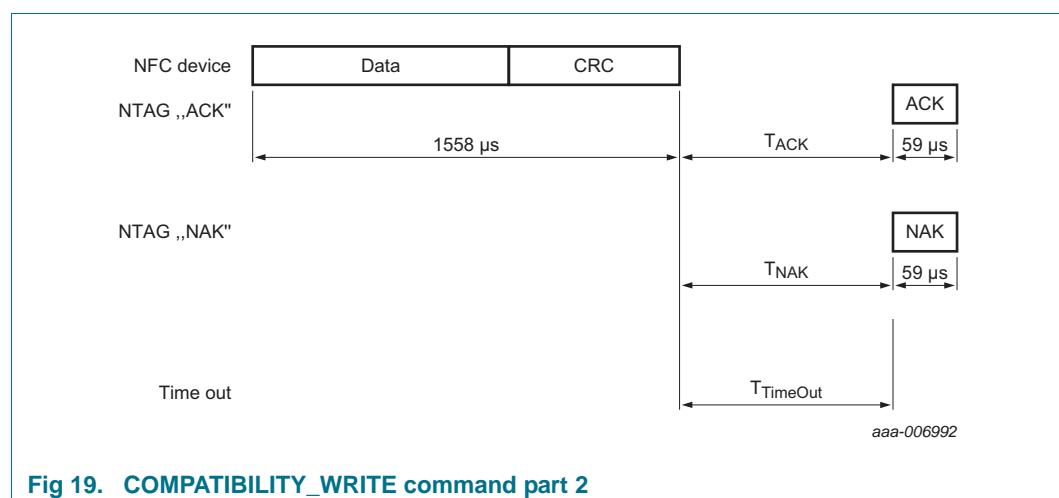
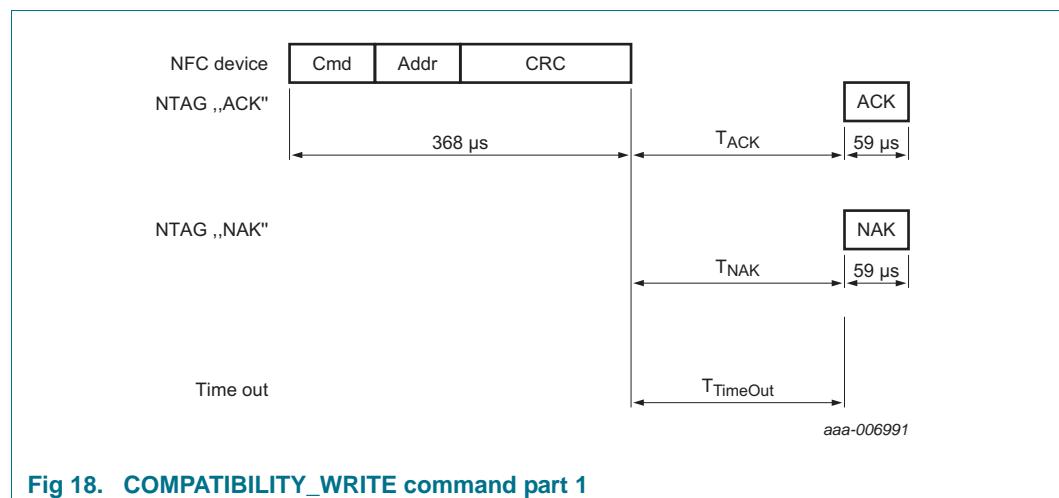
NTAG21x features tearing protected write operations to specific memory content. The following pages are protected against tearing events during a WRITE operation:

- page 02h containing static lock bits
- page 03h containing CC bits
- page 28h containing the additional dynamic lock bits for the NTAG213
- page 82h containing the additional dynamic lock bits for the NTAG215
- page E2h containing the additional dynamic lock bits for the NTAG216

## 10.5 COMPATIBILITY\_WRITE

The COMPATIBILITY\_WRITE command is implemented to guarantee interoperability with the established MIFARE Classic PCD infrastructure, in case of coexistence of ticketing and NFC applications. Even though 16 bytes are transferred to NTAG21x, only the least significant 4 bytes (bytes 0 to 3) are written to the specified address. Set all the remaining bytes, 04h to 0Fh, to logic 00h. The COMPATIBILITY\_WRITE command is shown in [Figure 18](#), [Figure 19](#) and [Table 35](#).

[Table 36](#) shows the required timing.



**Table 35. COMPATIBILITY\_WRITE command**

Name	Code	Description	Length
Cmd	A0h	compatibility write	1 byte
Addr	-	page address	1 byte
CRC	-	CRC according to <a href="#">Ref. 1</a>	2 bytes
Data	-	16-byte Data, only least significant 4 bytes are written	16 bytes
NAK	see <a href="#">Table 23</a>	see <a href="#">Section 9.3</a>	4-bit

**Table 36. COMPATIBILITY\_WRITE timing***These times exclude the end of communication of the NFC device.*

	$T_{ACK/NAK\ min}$	$T_{ACK/NAK\ max}$	$T_{TimeOut}$
COMPATIBILITY_WRITE part 1	$n=9$ <sup>[1]</sup>	$T_{TimeOut}$	5 ms
COMPATIBILITY_WRITE part 2	$n=9$ <sup>[1]</sup>	$T_{TimeOut}$	10 ms

[1] Refer to [Section 9.2 "Timings"](#).

In the initial state of NTAG21x, the following memory pages are valid Addr parameters to the COMPATIBILITY\_WRITE command.

- page address 02h to 2Ch for NTAG213
- page address 02h to 86h for NTAG215
- page address 02h to E6h for NTAG216

Addressing a memory page beyond the limits above results in a NAK response from NTAG21x.

Pages which are locked against writing cannot be reprogrammed using any write command. The locking mechanisms include static and dynamic lock bits as well as the locking of the configuration pages.

The following conditions apply if part of the memory is password protected for write access:

- if NTAG21x is in the ACTIVE state
  - writing to a page which address is equal or higher than AUTH0 results in a NAK response
- if NTAG21x is in the AUTHENTICATED state
  - the COMPATIBILITY\_WRITE command behaves the same as on a NTAG21x without access protection

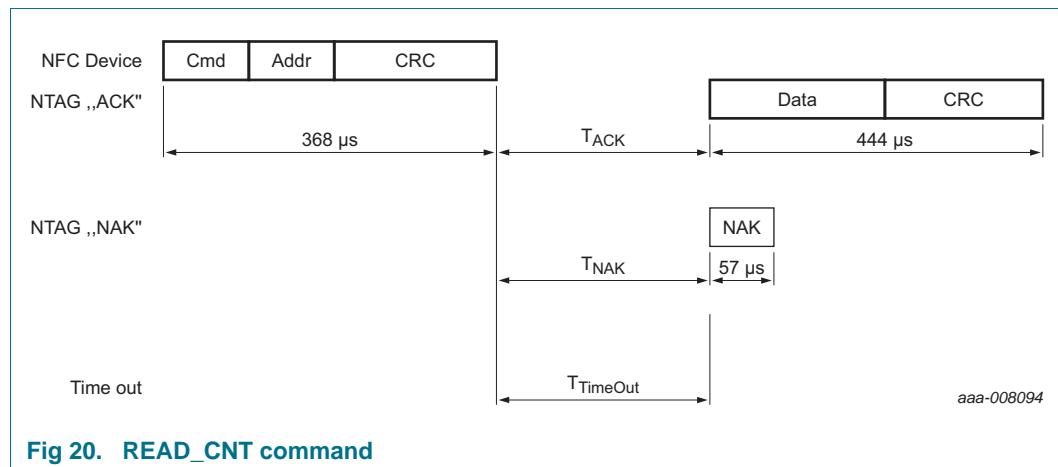
NTAG21x features tearing protected write operations to specific memory content. The following pages are protected against tearing events during a COMPATIBILITY\_WRITE operation:

- page 02h containing static lock bits
- page 03h containing CC bits
- page 28h containing the additional dynamic lock bits for the NTAG213
- page 82h containing the additional dynamic lock bits for the NTAG215
- page E2h containing the additional dynamic lock bits for the NTAG216

## 10.6 READ\_CNT

The READ\_CNT command is used to read out the current value of the NFC one-way counter of the NTAG213, NTAG215 and NTAG216. The command has a single argument specifying the counter number and returns the 24-bit counter value of the corresponding counter. If the NFC\_CNT\_PWD\_PROT bit is set to 1b the counter is password protected and can only be read with the READ\_CNT command after a previous valid password authentication (see [Section 10.7](#)). The command structure is shown in [Figure 20](#) and [Table 37](#).

[Table 38](#) shows the required timing.



**Fig 20. READ\_CNT command**

**Table 37. READ\_CNT command**

Name	Code	Description	Length
Cmd	39h	read counter	1 byte
Addr	02h	NFC counter address	1 byte
CRC	-	CRC according to <a href="#">Ref. 1</a>	2 bytes
Data	-	counter value	3 bytes
NAK	see <a href="#">Table 23</a>	see <a href="#">Section 9.3</a>	4-bit

**Table 38. READ\_CNT timing**

These times exclude the end of communication of the NFC device.

	$T_{ACK/NAK}$ min	$T_{ACK/NAK}$ max	$T_{TimeOut}$
READ_CNT	$n=9$ <sup>[1]</sup>	$T_{TimeOut}$	5 ms

[1] Refer to [Section 9.2 "Timings"](#).

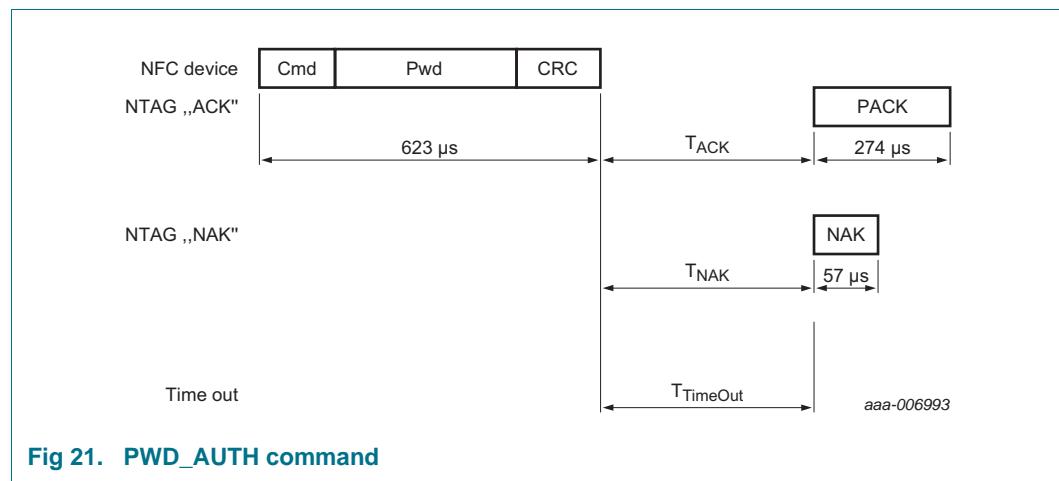
The following conditions apply if the NFC counter is password protected:

- if NTAG21x is in the ACTIVE state
  - Response to the READ\_CNT command results in a NAK response
- if NTAG21x is in the AUTHENTICATED state
  - Response to the READ\_CNT command is the current counter value plus CRC

## 10.7 PWD\_AUTH

A protected memory area can be accessed only after a successful password verification using the PWD\_AUTH command. The AUTH0 configuration byte defines the protected area. It specifies the first page that the password mechanism protects. The level of protection can be configured using the PROT bit either for write protection or read/write protection. The PWD\_AUTH command takes the password as parameter and, if successful, returns the password authentication acknowledge, PACK. By setting the AUTHLIM configuration bits to a value larger than 000b, the number of unsuccessful password verifications can be limited. Each unsuccessful authentication is then counted in a counter featuring anti-tearing support. After reaching the limit of unsuccessful attempts, the memory access specified in PROT, is no longer possible. The PWD\_AUTH command is shown in [Figure 21](#) and [Table 39](#).

[Table 40](#) shows the required timing.



**Fig 21. PWD\_AUTH command**

**Table 39. PWD\_AUTH command**

Name	Code	Description	Length
Cmd	1Bh	password authentication	1 byte
Pwd	-	password	4 bytes
CRC	-	CRC according to <a href="#">Ref. 1</a>	2 bytes
PACK	-	password authentication acknowledge	2 bytes
NAK	see <a href="#">Table 23</a>	see <a href="#">Section 9.3</a>	4-bit

**Table 40. PWD\_AUTH timing**

These times exclude the end of communication of the NFC device.

	TACK/NAK min	TACK/NAK max	TTimeOut
PWD_AUTH	n=9 <sup>[1]</sup>	TTimeOut	5 ms

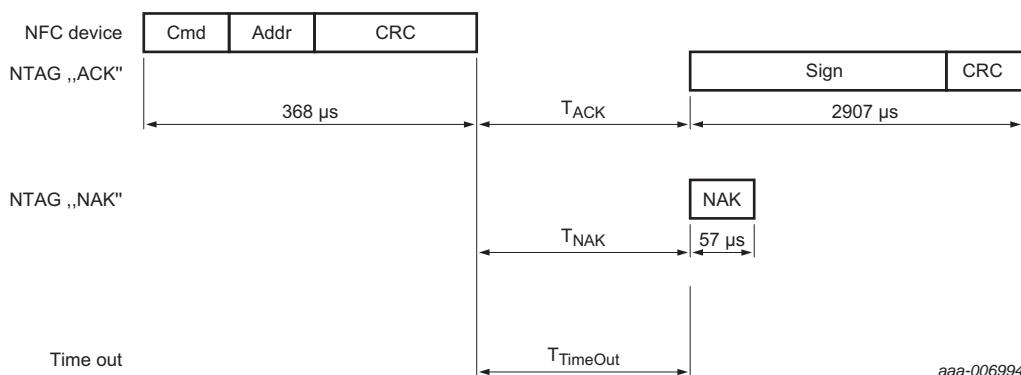
[1] Refer to [Section 9.2 "Timings"](#).

**Remark:** It is strongly recommended to change the password from its delivery state at tag issuing and set the AUTH0 value to the PWD page.

## 10.8 READ\_SIG

The READ\_SIG command returns an IC specific, 32-byte ECC signature, to verify NXP Semiconductors as the silicon vendor. The signature is programmed at chip production and cannot be changed afterwards. The command structure is shown in [Figure 22](#) and [Table 41](#).

[Table 42](#) shows the required timing.



**Fig 22. READ\_SIG command**

**Table 41. READ\_SIG command**

Name	Code	Description	Length
Cmd	3Ch	read ECC signature	1 byte
Addr	00h	RFU, is set to 00h	1 byte
CRC	-	CRC according to <a href="#">Ref. 1</a>	2 bytes
Signature	-	ECC signature	32 bytes
NAK	see <a href="#">Table 23</a>	see <a href="#">Section 9.3</a>	4 bit

**Table 42. READ\_SIG timing**

These times exclude the end of communication of the NFC device.

	T <sub>ACK/NAK</sub> min	T <sub>ACK/NAK</sub> max	T <sub>TimeOut</sub>
READ_SIG	n=9 <sup>[1]</sup>	T <sub>TimeOut</sub>	5 ms

[1] Refer to [Section 9.2 "Timings"](#).

Details on how to check the signature value are provided in the following Application note ([Ref. 5](#)). It is foreseen to offer an online and offline way to verify originality of NTAG21x.

## 11. Limiting values

Stresses exceeding one or more of the limiting values can cause permanent damage to the device. Exposure to limiting values for extended periods can affect device reliability.

**Table 43. Limiting values**

*In accordance with the Absolute Maximum Rating System (IEC 60134).*

Symbol	Parameter	Min	Max	Unit
I <sub>I</sub>	input current	-	40	mA
P <sub>tot</sub>	total power dissipation	-	120	mW
T <sub>stg</sub>	storage temperature	-55	125	°C
V <sub>ESD</sub>	electrostatic discharge voltage on LA/LB	[1]	2	-
				kV

[1] ANSI/ESDA/JEDEC JS-001; Human body model: C = 100 pF, R = 1.5 kΩ

## 12. Characteristics

**Table 44. Characteristics**

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
T <sub>amb</sub>	ambient temperature		-25	-	70	°C
C <sub>i</sub>	input capacitance		-	50.0	-	pF
f <sub>i</sub>	input frequency		-	13.56	-	MHz
<b>EEPROM characteristics</b>						
t <sub>ret</sub>	retention time	T <sub>amb</sub> = 22 °C	10	-	-	year
N <sub>endu(W)</sub>	write endurance	T <sub>amb</sub> = 22 °C	100.000	-	-	cycle

## 13. Wafer specification

For more details on the wafer delivery forms see [Ref. 5](#).

**Table 45. Wafer specifications NTAG213/215/216**

<b>Wafer</b>	
diameter	200 mm typical (8 inches)
maximum diameter after foil expansion	210 mm
thickness	
NT2L1x11G0DUD	120 $\mu\text{m} \pm 15 \mu\text{m}$
NT2L1x11G0DUF	75 $\mu\text{m} \pm 10 \mu\text{m}$
flatness	not applicable
Potential Good Dies per Wafer (PGDW)	86470
<b>Wafer backside</b>	
material	Si
treatment	ground and stress relieve
roughness	$R_a$ max = 0.5 $\mu\text{m}$ $R_t$ max = 5 $\mu\text{m}$
<b>Chip dimensions</b>	
step size <sup>[1]</sup>	x = 505 $\mu\text{m}$ y = 720 $\mu\text{m}$
gap between chips <sup>[1]</sup>	typical = 20 $\mu\text{m}$ minimum = 5 $\mu\text{m}$
<b>Passivation</b>	
type	sandwich structure
material	PSG / nitride
thickness	500 nm / 600 nm
<b>Au bump (substrate connected to VSS)</b>	
material	> 99.9 % pure Au
hardness	35 to 80 HV 0.005
shear strength	> 70 MPa
height	18 $\mu\text{m}$
height uniformity	within a die = $\pm 2 \mu\text{m}$ within a wafer = $\pm 3 \mu\text{m}$ wafer to wafer = $\pm 4 \mu\text{m}$
flatness	minimum = $\pm 1.5 \mu\text{m}$
size	LA, LB, GND, TP <sup>[2]</sup> = 60 $\mu\text{m} \times$ 60 $\mu\text{m}$
size variation	$\pm 5 \mu\text{m}$
under bump metallization	sputtered TiW

[1] The step size and the gap between chips may vary due to changing foil expansion

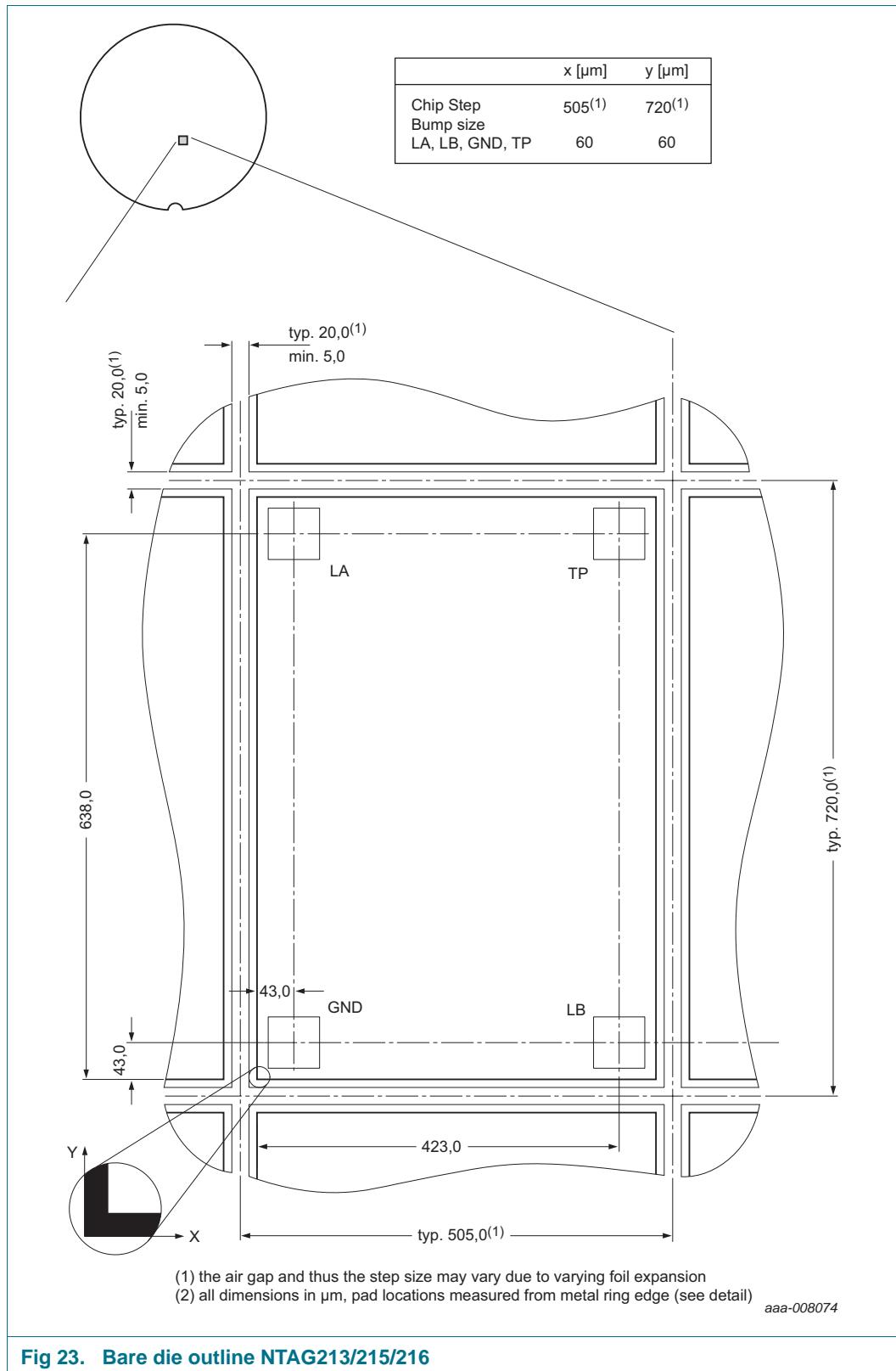
[2] Pads GND and TP are disconnected when wafer is sawn

### 13.1 Fail die identification

Electronic wafer mapping covers the electrical test results and additionally the results of mechanical/visual inspection. No ink dots are applied.

### 13.2 Bare die outline

For more details on the wafer delivery forms see [Ref. 5](#).



## 14. Abbreviations

Table 46. Abbreviations and symbols

Acronym	Description
ACK	ACKnowledge
ATQA	Answer To reQuest, Type A
CRC	Cyclic Redundancy Check
CC	Capability container
CT	Cascade Tag (value 88h) as defined in ISO/IEC 14443-3 Type A
ECC	Elliptic Curve Cryptography
EEPROM	Electrically Erasable Programmable Read-Only Memory
FDT	Frame Delay Time
FFC	Film Frame Carrier
IC	Integrated Circuit
LCR	L = inductance, Capacitance, Resistance (LCR meter)
LSB	Least Significant Bit
NAK	Not ACKnowledge
NFC device	NFC Forum device
NFC tag	NFC Forum tag
NV	Non-Volatile memory
REQA	REQuest command, Type A
RF	Radio Frequency
RFUI	Reserver for Future Use - Implemented
RMS	Root Mean Square
SAK	Select ACKnowledge, type A
SECS-II	SEMI Equipment Communications Standard part 2
TiW	Titanium Tungsten
UID	Unique IDentifier
WUPA	Wake-Up Protocol type A

## 15. References

- [1] **ISO/IEC 14443** — International Organization for Standardization
- [2] **NFC Forum Tag 2 Type Operation, Technical Specification** — NFC Forum, 31.05.2011, Version 1.1
- [3] **NFC Data Exchange Format (NDEF), Technical Specification** — NFC Forum, 24.07.2006, Version 1.0
- [4] **AN11276 NTAG Antenna Design Guide** — Application note, BU-ID Document number 2421\*\*<sup>1</sup>
- [5] **AN11350 NTAG21x Originality Signature Validation** — Application note, BU-ID Document number 2604\*\*<sup>1</sup>
- [6] **General specification for 8" wafer on UV-tape; delivery types** — Delivery Type Description, BU-ID Document number 1005\*\*<sup>1</sup>
- [7] **Certicom Research. SEC 2** — Recommended Elliptic Curve Domain Parameters, version 2.0, January 2010
- [8] **AN11456 NTAG21x Using the dynamic lock bits to lock the tag** — Application note, BU-ID Document number 2769\*\*<sup>1</sup>

---

1. \*\* ... BU ID document version number

## 16. Revision history

**Table 47. Revision history**

Document ID	Release date	Data sheet status	Change notice	Supersedes
NTAG213_215_216 v.3.1	20131213	Product data sheet	CIN 20131201I	NTAG213_215_216 v.3.0
Modifications:			<ul style="list-style-type: none"> <li>Modification of capability container content at delivery for NTAG215 and NTAG216 in <a href="#">Section 8.5.4 "Capability Container (CC bytes)"</a></li> <li>Modification of memory content at delivery for NTAG215 and NTAG 216 in <a href="#">Section 8.5.6 "Memory content at delivery"</a></li> </ul>	
NTAG213_215_216 v.3.0	20130724	Product data sheet		NTAG213_215_216 v.2.0
Modifications:			<ul style="list-style-type: none"> <li>Hexadecimal addresses for NTAG213 in <a href="#">Figure 4</a> and Tables <a href="#">14</a>, <a href="#">15</a>, <a href="#">17</a>, <a href="#">18</a>, <a href="#">20</a>, <a href="#">21</a> corrected</li> <li>Dynamic lock bytes addresses for NTAG215 (<a href="#">Figure 10</a>) and NTAG216 (<a href="#">Figure 11</a>) corrected</li> <li>Number of Possible Good Dies per Wafer (PGDW) and step size in <a href="#">Table 45</a> corrected</li> <li>Memory content in Tables <a href="#">14</a>, <a href="#">15</a>, <a href="#">17</a>, <a href="#">18</a>, <a href="#">20</a>, <a href="#">21</a> corrected</li> <li><a href="#">Table 2 "Ordering information"</a>: corrected</li> </ul>	
NTAG213_215_216 v.2.0	20130528	Preliminary data sheet	-	-
			<ul style="list-style-type: none"> <li>Initial version</li> </ul>	

## 17. Legal information

### 17.1 Data sheet status

Document status <sup>[1][2]</sup>	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL <http://www.nxp.com>.

### 17.2 Definitions

**Draft** — The document is a draft version only. The content is still under internal review and subject to formal approval, which may result in modifications or additions. NXP Semiconductors does not give any representations or warranties as to the accuracy or completeness of information included herein and shall have no liability for the consequences of use of such information.

**Short data sheet** — A short data sheet is an extract from a full data sheet with the same product type number(s) and title. A short data sheet is intended for quick reference only and should not be relied upon to contain detailed and full information. For detailed and full information see the relevant full data sheet, which is available on request via the local NXP Semiconductors sales office. In case of any inconsistency or conflict with the short data sheet, the full data sheet shall prevail.

**Product specification** — The information and data provided in a Product data sheet shall define the specification of the product as agreed between NXP Semiconductors and its customer, unless NXP Semiconductors and customer have explicitly agreed otherwise in writing. In no event however, shall an agreement be valid in which the NXP Semiconductors product is deemed to offer functions and qualities beyond those described in the Product data sheet.

**Suitability for use** — NXP Semiconductors products are not designed, authorized or warranted to be suitable for use in life support, life-critical or safety-critical systems or equipment, nor in applications where failure or malfunction of an NXP Semiconductors product can reasonably be expected to result in personal injury, death or severe property or environmental damage. NXP Semiconductors and its suppliers accept no liability for inclusion and/or use of NXP Semiconductors products in such equipment or applications and therefore such inclusion and/or use is at the customer's own risk.

**Applications** — Applications that are described herein for any of these products are for illustrative purposes only. NXP Semiconductors makes no representation or warranty that such applications will be suitable for the specified use without further testing or modification.

Customers are responsible for the design and operation of their applications and products using NXP Semiconductors products, and NXP Semiconductors accepts no liability for any assistance with applications or customer product design. It is customer's sole responsibility to determine whether the NXP Semiconductors product is suitable and fit for the customer's applications and products planned, as well as for the planned application and use of customer's third party customer(s). Customers should provide appropriate design and operating safeguards to minimize the risks associated with their applications and products.

NXP Semiconductors does not accept any liability related to any default, damage, costs or problem which is based on any weakness or default in the customer's applications or products, or the application or use by customer's third party customer(s). Customer is responsible for doing all necessary testing for the customer's applications and products using NXP Semiconductors products in order to avoid a default of the applications and the products or of the application or use by customer's third party customer(s). NXP does not accept any liability in this respect.

**Limiting values** — Stress above one or more limiting values (as defined in the Absolute Maximum Ratings System of IEC 60134) will cause permanent damage to the device. Limiting values are stress ratings only and (proper) operation of the device at these or any other conditions above those given in the Recommended operating conditions section (if present) or the Characteristics sections of this document is not warranted. Constant or repeated exposure to limiting values will permanently and irreversibly affect the quality and reliability of the device.

**Terms and conditions of commercial sale** — NXP Semiconductors products are sold subject to the general terms and conditions of commercial sale, as published at <http://www.nxp.com/profile/terms>, unless otherwise agreed in a valid written individual agreement. In case an individual agreement is concluded only the terms and conditions of the respective agreement shall apply. NXP Semiconductors hereby expressly objects to applying the customer's general terms and conditions with regard to the purchase of NXP Semiconductors products by customer.

**No offer to sell or license** — Nothing in this document may be interpreted or construed as an offer to sell products that is open for acceptance or the grant, conveyance or implication of any license under any copyrights, patents or other industrial or intellectual property rights.

### 17.3 Disclaimers

**Limited warranty and liability** — Information in this document is believed to be accurate and reliable. However, NXP Semiconductors does not give any representations or warranties, expressed or implied, as to the accuracy or completeness of such information and shall have no liability for the consequences of use of such information. NXP Semiconductors takes no responsibility for the content in this document if provided by an information source outside of NXP Semiconductors.

In no event shall NXP Semiconductors be liable for any indirect, incidental, punitive, special or consequential damages (including - without limitation - lost profits, lost savings, business interruption, costs related to the removal or replacement of any products or rework charges) whether or not such damages are based on tort (including negligence), warranty, breach of contract or any other legal theory.

Notwithstanding any damages that customer might incur for any reason whatsoever, NXP Semiconductors' aggregate and cumulative liability towards customer for the products described herein shall be limited in accordance with the *Terms and conditions of commercial sale* of NXP Semiconductors.

**Right to make changes** — NXP Semiconductors reserves the right to make changes to information published in this document, including without limitation specifications and product descriptions, at any time and without notice. This document supersedes and replaces all information supplied prior to the publication hereof.

**Export control** — This document as well as the item(s) described herein may be subject to export control regulations. Export might require a prior authorization from competent authorities.

**Quick reference data** — The Quick reference data is an extract of the product data given in the Limiting values and Characteristics sections of this document, and as such is not complete, exhaustive or legally binding.

**Non-automotive qualified products** — Unless this data sheet expressly states that this specific NXP Semiconductors product is automotive qualified, the product is not suitable for automotive use. It is neither qualified nor tested in accordance with automotive testing or application requirements. NXP Semiconductors accepts no liability for inclusion and/or use of non-automotive qualified products in automotive equipment or applications.

In the event that customer uses the product for design-in and use in automotive applications to automotive specifications and standards, customer (a) shall use the product without NXP Semiconductors' warranty of the product for such automotive applications, use and specifications, and (b) whenever customer uses the product for automotive applications beyond NXP Semiconductors' specifications such use shall be solely at customer's own risk, and (c) customer fully indemnifies NXP Semiconductors for any

liability, damages or failed product claims resulting from customer design and use of the product for automotive applications beyond NXP Semiconductors' standard warranty and NXP Semiconductors' product specifications.

## 17.4 Licenses

### Purchase of NXP ICs with NFC technology

Purchase of an NXP Semiconductors IC that complies with one of the Near Field Communication (NFC) standards ISO/IEC 18092 and ISO/IEC 21481 does not convey an implied license under any patent right infringed by implementation of any of those standards.

## 17.5 Trademarks

Notice: All referenced brands, product names, service names and trademarks are the property of their respective owners.

**MIFARE** — is a trademark of NXP B.V.

## 18. Contact information

For more information, please visit: <http://www.nxp.com>

For sales office addresses, please send an email to: [salesaddresses@nxp.com](mailto:salesaddresses@nxp.com)

This device has been tested and found to comply with the limits for a Class B digital device, pursuant to Part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference in a residential installation. This device generates, uses and can radiate radio frequency energy and, if not installed and used in accordance with the instructions, may cause harmful interference to radio communications.

However, there is no guarantee that interference will not occur in a particular installation. If this device does cause harmful interference to radio or television reception, which can be determined by turning the device off and on, the user is encouraged to try to correct the interference by one or more of the following measures:

- Reorient or relocate the receiving antenna.
- Increase the separation between the device and receiver.
- Connect the device into an outlet on a circuit different from that to which the receiver is connected.
- Consult the dealer or an experienced radio/TV technician for help

Changes or modifications not expressly approved by the party responsible for compliance could void the user's authority to operate the equipment.

This device complies with part 15 of the FCC rules. Operation is subject to the following two conditions: (1) this device may not cause harmful interference, and (2) this device must accept any interference received, including interference that may cause undesired operation.

## 19. Tables

Table 1. Quick reference data .....	4	Table 24. ATQA response of the NTAG21x .....	34
Table 2. Ordering information .....	4	Table 25. SAK response of the NTAG21x .....	34
Table 3. Pin allocation table .....	6	Table 26. GET_VERSION command .....	35
Table 4. NDEF memory size .....	16	Table 27. GET_VERSION timing .....	35
Table 5. Memory content at delivery NTAG213 .....	17	Table 28. GET_VERSION response for NTAG213, NTAG215 and NTAG216 .....	36
Table 6. Memory content at delivery NTAG215 .....	17	Table 29. READ command .....	37
Table 7. Memory content at delivery NTAG216 .....	17	Table 30. READ timing .....	37
Table 8. Configuration Pages .....	18	Table 31. FAST_READ command .....	39
Table 9. MIRROR configuration byte .....	18	Table 32. FAST_READ timing .....	39
Table 10. ACCESS configuration byte .....	18	Table 33. WRITE command .....	41
Table 11. Configuration parameter descriptions .....	18	Table 34. WRITE timing .....	41
Table 12. Required memory space for ASCII mirror .....	20	Table 35. COMPATIBILITY_WRITE command .....	43
Table 13. Configuration parameter description .....	21	Table 36. COMPATIBILITY_WRITE timing .....	44
Table 14. UID ASCII mirror - Physical memory content .....	22	Table 37. READ_CNT command .....	45
Table 15. UID ASCII mirror - Virtual memory content .....	23	Table 38. READ_CNT timing .....	45
Table 16. Configuration parameter description .....	24	Table 39. PWD_AUTH command .....	46
Table 17. NFC counter mirror - Physical memory content .....	25	Table 40. PWD_AUTH timing .....	46
Table 18. NFC counter mirror - Virtual memory content .....	26	Table 41. READ_SIG command .....	47
Table 19. Configuration parameter description .....	27	Table 42. READ_SIG timing .....	47
Table 20. UID and NFC counter ASCII mirror - Physical memory content .....	28	Table 43. Limiting values .....	48
Table 21. UID and NFC counter ASCII mirror - Physical memory content .....	29	Table 44. Characteristics .....	48
Table 22. Command overview .....	32	Table 45. Wafer specifications NTAG213/215/216 .....	49
Table 23. ACK and NAK values .....	33	Table 46. Abbreviations and symbols .....	52
		Table 47. Revision history .....	54

## 20. Figures

Fig 1. Contactless system .....	2
Fig 2. Block diagram of NTAG213/215/216 .....	5
Fig 3. State diagram .....	8
Fig 4. Memory organization NTAG213 .....	11
Fig 5. Memory organization NTAG215 .....	11
Fig 6. Memory organization NTAG216 .....	12
Fig 7. UID/serial number .....	12
Fig 8. Static lock bytes 0 and 1 .....	13
Fig 9. NTAG213 Dynamic lock bytes 0, 1 and 2 .....	14
Fig 10. NTAG215 Dynamic lock bytes 0, 1 and 2 .....	14
Fig 11. NTAG216 Dynamic lock bytes 0, 1 and 2 .....	15
Fig 12. CC bytes example .....	16
Fig 13. Frame Delay Time (from NFC device to NFC tag) .....	33
Fig 14. GET_VERSION command .....	35
Fig 15. READ command .....	37
Fig 16. FAST_READ command .....	39
Fig 17. WRITE command .....	41
Fig 18. COMPATIBILITY_WRITE command part 1 .....	43
Fig 19. COMPATIBILITY_WRITE command part 2 .....	43
Fig 20. READ_CNT command .....	45
Fig 21. PWD_AUTH command .....	46
Fig 22. READ_SIG command .....	47
Fig 23. Bare die outline NTAG213/215/216 .....	51

## 21. Contents

<b>1</b>	<b>General description</b>	<b>1</b>	<b>9</b>	<b>Command overview</b>	<b>32</b>
1.1	Contactless energy and data transfer	1	9.1	NTAG21x command overview	32
1.2	Simple deployment and user convenience	2	9.2	Timings	32
1.3	Security	2	9.3	NTAG ACK and NAK	33
1.4	NFC Forum Tag 2 Type compliance	2	9.4	ATQA and SAK responses	34
1.5	Anticollision	2	<b>10</b>	<b>NTAG commands</b>	<b>35</b>
<b>2</b>	<b>Features and benefits</b>	<b>3</b>	10.1	GET_VERSION	35
2.1	EEPROM	3	10.2	READ	37
<b>3</b>	<b>Applications</b>	<b>3</b>	10.3	FAST_READ	39
<b>4</b>	<b>Quick reference data</b>	<b>4</b>	10.4	WRITE	41
<b>5</b>	<b>Ordering information</b>	<b>4</b>	10.5	COMPATIBILITY_WRITE	43
<b>6</b>	<b>Block diagram</b>	<b>5</b>	10.6	READ_CNT	45
<b>7</b>	<b>Pinning information</b>	<b>6</b>	10.7	PWD_AUTH	46
7.1	Pinning	6	10.8	READ_SIG	47
<b>8</b>	<b>Functional description</b>	<b>6</b>	<b>11</b>	<b>Limiting values</b>	<b>48</b>
8.1	Block description	6	<b>12</b>	<b>Characteristics</b>	<b>48</b>
8.2	RF interface	7	<b>13</b>	<b>Wafer specification</b>	<b>49</b>
8.3	Data integrity	7	13.1	Fail die identification	50
8.4	Communication principle	8	13.2	<b>Bare die outline</b>	<b>50</b>
8.4.1	IDLE state	9	<b>14</b>	<b>Abbreviations</b>	<b>52</b>
8.4.2	READY1 state	9	<b>15</b>	<b>References</b>	<b>53</b>
8.4.3	READY2 state	9	<b>16</b>	<b>Revision history</b>	<b>54</b>
8.4.4	ACTIVE state	10	<b>17</b>	<b>Legal information</b>	<b>55</b>
8.4.5	AUTHENTICATED state	10	17.1	Data sheet status	55
8.4.6	HALT state	10	17.2	Definitions	55
8.5	Memory organization	11	17.3	Disclaimers	55
8.5.1	UID/serial number	12	17.4	Licenses	56
8.5.2	Static lock bytes (NTAG21x)	12	17.5	Trademarks	56
8.5.3	Dynamic Lock Bytes	13	<b>18</b>	<b>Contact information</b>	<b>56</b>
8.5.4	Capability Container (CC bytes)	16	<b>19</b>	<b>Tables</b>	<b>57</b>
8.5.5	Data pages	16	<b>20</b>	<b>Figures</b>	<b>57</b>
8.5.6	Memory content at delivery	17	<b>21</b>	<b>Contents</b>	<b>58</b>
8.5.7	Configuration pages	18			
8.6	NFC counter function	19			
8.7	ASCII mirror function	20			
8.7.1	UID ASCII mirror function	21			
8.7.1.1	UID ASCII Mirror example	22			
8.7.2	NFC counter mirror function	23			
8.7.2.1	NFC counter mirror example	25			
8.7.3	UID and NFC counter mirror function	26			
8.7.3.1	UID and NFC counter mirror example	28			
8.8	Password verification protection	30			
8.8.1	Programming of PWD and PACK	30			
8.8.2	Limiting negative verification attempts	31			
8.8.3	Protection of special memory segments	31			
8.9	Originality signature	31			

Please be aware that important notices concerning this document and the product(s) described herein, have been included in section 'Legal information'.